

**DETAILED SALE PROCESS DOCUMENT FOR SALE OF THE
STOCK (FINISHED GOODS AND RAW MATERIALS).**

Invitation for Bid for stocks of VIN SEMICONDUCTORS PRIVATE LIMITED undergoing Corporate Insolvency Resolution Process (CIRP) in accordance with Insolvency and Bankruptcy Code, 2016 pursuant to **an Order of the Hon'ble National Company Law Tribunal, Mumbai Bench ("NCLT") dated 10th November, 2023**

Date of Public Announcement

9th May, 2024

Last Date for submission of Bid

20th May, 2024

Issued by:

Mr. Prashant Jain

Resolution Professional

IP Registration No. IBBI/IPA-001/IP-P01368/2018-19/12131

VIN SEMICONDUCTORS PRIVATE LIMITED

Undergoing Corporate Insolvency Resolution Process (CIRP) in accordance with Insolvency and Bankruptcy Code, 2016

Registered Office of the Corporate Debtor: 306/307, Marathon Max, LBS Marg, Opp. Nirmal Lifestyle, Mulund (West) Mumbai-400080 Maharashtra.

Email ID: ipprashantjain@gmail.com ; vinled.cirp@gmail.com

Mr. Prashant Jain, Partner, SSARVI RESOLUTION SERVICES LLP is a Registered Insolvency Professional with the Insolvency and Bankruptcy Board of India (IBBI). His IBBI Registration Number is: IBBI/IPA-001/IP-P01368/2018-19/12131. Mr. Prashant Jain has been appointed as the Resolution Professional of Vin Semiconductors Private Limited (in CIRP) by Hon'ble National Company Law Tribunal (NCLT), Mumbai Bench vide order dated 10th November, 2023 to conduct the corporate insolvency resolution process and manage the affairs of Vin Semiconductors Private Limited (in CIRP).

Regd. Add of the RP- A501, Shanti Heights, Plot No. 2, 3, 9B/10, Sector 11, Koparkharine, Thane, Navi Mumbai, MH – 400 709

Correspondence Address: 610, B Wing, BSEL Tech Park, Sector 30A, Opposite Vashi Railway Station, Vashi, Navi Mumbai, Maharashtra, 400705

Regd. Email ID: ipprashantjain@gmail.com;

Correspondence Email – vinled.cirp@gmail.com

Notes:

- 1.** This Invitation for bid for purchase of the Stock Process Information Document is issued only for the Interested Bidders.
- 2.** Terms and Conditions, deadlines etc. for participating in the bid for purchase of the Stock are provided in this Process Document. The timelines, notifications, updates and other details for the Invitation for bid for purchase of the said aforesaid stock are available on the website of the Vin Semiconductors Private Limited <https://vinled.com> Insolvency Professional Entity of the Resolution Professional, i.e., <https://ssarvi.com>.
- 3.** The Bidders desirous to submit their Bid have to submit their Bids for purchase of stock in manner prescribed in this document at correspondence address of the resolution professional before 5:00 PM of 20th May, 2024.

DISCLAIMER

1. *This Process Document for Invitation for bids for purchase of the Stock is issued by Mr. Prashant Jain, the Resolution Professional appointed by NCLT, in the matter of Vin Semiconductors Private Limited (in CIRP) general information purposes only.*
2. *The purpose of this document is to lay out the process for submitting the bids for purchase of the Stock of Vin Semiconductors Private Limited (in CIRP) (the “Company” or “Corporate Debtor”).*
3. *This document is not a statutory document and it has not been approved or registered with any regulatory or statutory authority of Government of India or any State Government. Nothing herein or in materials relating to the Process Information Document of Invitation for bids for purchase of the Stock should be construed as legal, financial, accounting, regulatory or tax advice by the Resolution Professional.*
4. *It is to be noted that no information being provided in this Process Information Document, claims to be comprehensive; independent due diligence of the intended users of this document or the bidders is highly recommended.*
5. *This Process Document and information contained herein or disclosed should not be printed, reproduced, transmitted, sold, distributed, or published by the recipient, without prior written approval from the Resolution Professional.*
6. *Neither the Resolution Professional, nor his Insolvency Professional Entity, his Partners, Legal Associates, etc. shall be liable for any damages, whether direct or indirect, including loss of revenue or profits that may arise from or in connection with the use of this Process Document for Invitation of bid for purchase of the Stock, including for the Participant not being selected as a Successful bidders or on account of any decision taken by the Resolution Professional.*
7. *Further, apart from the provisions set out in this Process Document, the Invitation for bids for purchase of the Stock process applicant shall be responsible for fully satisfying the requirements and provisions of the Insolvency and Bankruptcy Code, 2016 and the regulations thereunder as well as all laws in force that are or may be applicable to the applicant or the sale process and for obtaining requisite regulatory.*
8. *It is to be noted that by procuring a copy of this Process Document, the recipient accepts the terms of this disclaimer, which forms an integral part of this Process Document and part of all the other terms and conditions of this Process Information Document.*
9. *Under no circumstances shall the bidders make any contact, direct or indirect, by any mode whatsoever, with the Company until the Resolution Professional gives his Written Permission.*

10. *The Stock of the Company are proposed to be sold on “As is where is basis” and “No recourse” basis.*
11. *The Participant shall bear all its costs and charges associated with or relating to the preparation and submission of its bid including but not limited to Physical and Electronic preparation, copying, postage, delivery fees, expenses associated with any demonstrations or presentations which may be required by the Resolution Professional or any other costs incurred in connection with or relating to its bid.*
12. *This Process Document for Invitation of bid for purchase of the Stock is neither an agreement nor an offer by the Resolution Professional to the Prospective Bidders or any other person. The objective of this Process Information Document is to provide interested parties with information that may be useful to them in making their bids. It may be noted that the assumptions, assessments, statements and information contained in the Process Document may not be complete, accurate, adequate or correct. Each Bidder should, therefore, conduct its own due-diligence, investigations and analysis and should also check the accuracy, adequacy, correctness, reliability and completeness of the assumptions, assessments, statements and information contained in this Process Document and may get independent advice from appropriate sources.*
13. *Information provided in this Process Document to the Bidder(s) has been collected and collated from several sources. The information given by no means claims to be an exhaustive account of statutory requirements and should not be regarded as complete. The Resolution Professional accepts no liability or responsibility for the authenticity, accuracy or otherwise for any statement or information contained in the Process Information Document.*

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A. INFORMATION MUST BE READ BEFORE BIDDING

1. This Process Information Document has been issued for the purpose of Invitation for bid for purchase of the Stock of Vin Semiconductors Private Limited (in CIRP) (the “**Company**” or “**Corporate Debtor**”) under the provisions of the Insolvency and Bankruptcy Code, 2016 and Insolvency and Bankruptcy Board of India (Insolvency Resolution Process for Corporate Persons) Regulations, 2016 (CIRP Process) Regulations, 2016 (“**CIRP Regulations**”).
2. The information contained in this Process Information Document or subsequently provided to Bidder(s), whether verbally or in documentary or any other form by or on behalf of the Resolution Professional, is provided to Bidder(s) on the terms and conditions as set out in this Process Information Document.
3. The Resolution Professional may in his absolute discretion, but without being under any obligation to do so, update, amend or supplement the information, assessment or assumptions contained in this Process Information Document.
4. The issuance of this Process Information Document does not imply that the Resolution Professional is bound to select a Bidder or to appoint the Preferred Bidder as Successful Bidder for the stock of the company and the Resolution Professional reserves the right to reject all or any of the Bidders or bids without assigning any reason whatsoever.
5. The Annexures to this Process Document shall form an integral part hereof and this Process Information Document shall always be read in conjunction with the Annexures appended hereto.
6. In case of any inconsistency between the clauses of Notice for Invitation for Bid and this Process document. The clause of this Process document shall prevail.

B. KEY DEFINITIONS

“**Adjudicating Authority**” or “**NCLT**” shall mean the Hon’ble Mumbai Bench of the National Company Law Tribunal;

“**Applicable Laws**” shall mean, all the applicable laws, codes, regulations,

rules, guidelines, circulars, re-enactments, revisions, applications and adaptations thereto, judgments, decrees, injunctions, writs and orders of any court, arbitrator or governmental agency or authority, rules, regulations, orders and interpretations of any governmental authority, court or statutory or other body applicable for such transactions including but not limited to the IBC, CIRP Regulations, Companies Act, 1956 / 2013 (as applicable), Competition Act, 2002, Transfer of Property Act, 1882, Sale of Goods Act, 1930, Foreign Exchange Management Act, 1999, whether in effect as of the date of this Process Information Document or thereafter and each as amended from time to time;

“**Bid**” means, any bid submitted by the Bidders as required in terms of this Process Document and in accordance with the provisions of IBC read together with the CIRP Process Regulations and the Applicable Laws;

“**Control**” shall mean a Person holding more than 26% (twenty six percent) of the voting share capital in a company or the ability to appoint majority of the directors on the board of another company or the ability of a company to direct or cause direction of the management and policies of another company, whether by operation of law or by contract or otherwise;

“**Participant**” or “**Bidder**” mean, Person or Persons who submitted a bid as per the Process Document; and shall include a Qualified Bidder or the Successful Bidder, as the case may be, and as the context requires;

“**Process Document**” means this document including all the appendices hereto, for the purposes of setting out the process for submission of a bid and selection of Successful Bid in accordance with the provisions of the IBC and shall include all supplements, modifications, amendments, alterations or clarifications thereto issued in accordance with the terms hereof.

“**IBC**” shall mean Insolvency and Bankruptcy Code, 2016 and the related rules and regulations issued there under, as amended from time to time.

“**CIRP Regulations**” means, the Insolvency and Bankruptcy Board of India (Insolvency Resolution Process of Corporate Persons) Regulations, 2016 as amended from time to time;

“**Resolution Professional**” means an insolvency professional appointed as a Resolution Professional in accordance with section 16 or Section 23 of the IBC;

“**Person**” shall mean an individual, a partnership firm, an association, a corporation, a limited company, a trust, a body corporate, bank or financial institution or any other body, whether incorporated or not;

“**Qualified Bidder(s)**” shall mean a Bidder who fulfills the eligibility criteria listed out in the Process Document.

“**Successful Bidder**” means, the Qualified Bidder whose bid is approved by the Committee of Creditors (COC) and who is declared successful by the Resolution Professional in at the end of the determined auction phase.

C. INTRODUCTION

1. The Company’s CIRP Process has been initiated under the provisions of the IBC and the CIRP Regulations by an order of the NCLT with effect from 10th November, 2023 the undersigned, Mr. Prashant Jain as the Interim Resolution Professional. The appointment of Mr. Prashant Jain as a Resolution Professional was ratified in the 1st meeting of Committee of Creditors.
2. It is the endeavor of the Resolution Professional to sell the Stock of the Company through auction process in the ordinary course of business.
3. The Participants are encouraged to make themselves acquainted with the provisions of the IBC and the CIRP Regulations and any other rules, regulations, orders, circulars, directions or notifications or the like, issued pursuant to or under the IBC or the CIRP Regulations, as the case maybe.

D. THE COMPANY AND IT’S OVERVIEW

Brief Background:

Vin Semiconductors Private Limited (herein referred as ‘corporate debtor’) is a private limited company incorporated on 09/09/2009 under Companies Act, 1956. It is classified as an Indian Non – Government Company and is registered with RoC- Mumbai at the registered address 306/307, Marathon Max, LBS Marg, Opp. Nirmal Lifestyle, Mulund (West) Mumbai–400080 Maharashtra.

Invitation for bids for purchase of the stock (Raw Materials & Finished Goods) owned by Vin Semiconductors Private Limited –

Present Status:

On 10th November 2023 the National Company Law Tribunal, Mumbai Bench, initiated the Corporate Insolvency Resolution Process for the Company. Furthermore, NCLT vide its order dated 10th November 2023 in CP No. 299/IBC/NCLT/MB/MAH/2023 were pleased to appoint Mr. Prashant Jain, having Reg. No. IBBI/IPA-001/IP-P01368/2018-19/12131, as the Interim Resolution Professional and thereafter in the First COC Meeting the COC resolved to appoint him as the Resolution Professional (RP).

Further with consent of the Committee of Creditors (COC), the Resolution Professional is inviting for the bid for purchase of Stock of the Corporate Debtor.

The Resolution Professional has the custody and control of the entire factory including the stock (finished goods/raw material) of the of the company.

E. SALE OF STOCK OF THE CORPORATE DEBTOR

Identification of assets for sale and methodology adopted for sale by the Resolution Professional

Block	Class	Reserve Price	Earnest Money Deposit	Incremental Value
I	Entire stock at the price sum of Finished Goods and Raw Materials	71,66,071.27	7,10,000.00	50,000.00
II	All Finished Goods	44,14,183.00	4,40,000.00	50,000.00
III	All Raw Materials	27,51,888.27	2,75,000.00	50,000.00

The complete list of stock is mentioned in **Annexure IV** of this complete process document. Kindly note that the bids received for Block I shall be given preference over Block II & III.

Further, kindly note that the EMD amount must be remitted in the account mentioned in clause J(b) before 27th May, 2024

F. ELIGIBILITY

That the bidder / Process Applicant shall not be eligible to submit a bid for purchase of Stock of the Company if it fails to meet the eligibility criteria as set out in Section 29A of the IBC (as amended from time to time).

A careful reading of Section 29-A of the IBC states that a person shall not be eligible to submit a bid, if such person, or any other person acting jointly or in concert with such person –

- a) Is an undischarged insolvent;
- b) Is a willful defaulter in accordance with the guidelines of the Reserve Bank of India issued under the Banking Regulation Act, 1949;
- c) Has an account, or an account of a corporate debtor under the management or control of such person or of whom such person is a promoter, classified as non-performing asset in accordance with the guidelines of the Reserve Bank of India issued under the Banking Regulation Act 1949 or guidelines of a financial sector regulator issued under any other law for the time being in force and at least a period of one year has lapsed from the date of such classification till the date of commencement of the CIRP process of the corporate debtor.

Provided that the person shall be eligible to submit a bid if such person makes payment of all overdue amounts with interest thereon and charges relating to non-performing asset accounts before submission of bid;

Provided further that nothing in this clause shall apply to a bidder where such bidder is a financial entity and is not a related party to the corporate debtor.

- d) Has been convicted for any offence punishable with imprisonment:
 - i. for two years or more under any Act specified under the Twelfth Schedule; or
 - ii. for seven years or more under any law for the time being in force:

Provided that this clause shall not apply to a person after expiry of a period of two years from the date of his release from imprisonment:

- e) Is disqualified to act as a director under the Companies Act, 2013;
Provided that this clause shall not apply in relation to a connected person referred to in clause (iii) of explanation I
- f) Is prohibited by the Securities and Exchange Board of India from trading in securities or accessing the securities markets;
- g) Has been a promoter or in the management control of a corporate debtor in which a preferential transaction, undervalued transaction, extortionate credit transaction or fraudulent transaction has taken place and in respect of which an order has been made by the Adjudicating Authority under this Code;
- h) Has executed a guarantee in favour of a creditor in respect of a corporate debtor against which an application for insolvency resolution made by such creditor has been admitted under this Code and such guarantee has been

- invoked by the creditor and remains unpaid I full or part.
- i) is subject to any disability, corresponding to clauses (a) to (h), under any law in a jurisdiction outside India; or
 - j) Has a connected person not eligible under clauses (a) to (i)

Explanation – For the purposes of this clause, the expression “connected person” means

- i. *Any person who is the promoter or in the management or control of the E-auction process applicant; or*
- ii. *Any person who shall be the promoter or in management or control of the assets of the Company pursuant to sale thereof as part of the CIRP process of the Company; or*
- iii. *The holding company, subsidiary company, associate company or related party of a person referred to in clauses (i) and (ii)*

Provided that nothing in clause (iii) of this Explanation shall apply to a bidder where such bidder is a financial entity and is not a related party of the corporate debtor:

Provided further that the expression “related party” shall not include a financial entity regulated by a financial sector regulator, if it is a financial creditor of the corporate debtor and is a related party of the corporate debtor solely on account of conversion or substitution of debt into equity shares or instruments convertible into equity shares, prior to the insolvency commencement date.

Explanation II—For the purposes of this section, "financial entity" shall mean the following entities which meet such criteria or conditions as the Central Government may, in consultation with the financial sector regulator, notify in this behalf, namely:-

- (a) a scheduled bank;*
- (b) any entity regulated by a foreign central bank or a securities market regulator or other financial sector regulator of a jurisdiction outside India which jurisdiction is compliant with the Financial Action Task Force Standards and is a signatory to the International Organization of Securities Commissions Multilateral Memorandum of Understanding;*
- (c) any investment vehicle, registered foreign institutional investor, registered foreign portfolio investor or a foreign venture capital investor, where the terms shall have the meaning assigned to them in regulation 2 of the Foreign Exchange Management (Transfer or Issue of Security by a Person Resident Outside India) Regulations, 2017 made under the Foreign Exchange Management Act, 1999 (42 of 1999);*
- (d) an asset reconstruction company register with the Reserve Bank of India under section 3 of the Securitization and Reconstruction of*

- Financial Assets and Enforcement of Security Interest Act, 2002 (54 of 2002);*
- (e) an Alternate Investment Fund registered with Securities and Exchange Board of India;*
- (f) such categories of persons as may be notified by the Central Government.*

G. DOCUMENTS REQUIRED TO BE SUBMITTED TO BY THE BIDDER

1. The intending bidder should submit the following documents:
 - i. The Annexures I to III as mentioned in the Complete process document in Physical form and soft copy to be emailed to the Resolution Professional in a PDF document.
2. All the documents should reach the correspondence address of the Resolution Professional physically before 5 PM of 20th May, 2024.
3. The intending bidder should submit the Bid Application Form shall be in accordance with **Annexure-I** of this Process Document.
4. The Bidder shall have to submit the following Annexures as part of the Bid in separate Envelope:

The intending bidder should submit the Self attested copy of-

- Proof of Identification,
- Current Address-Proof,
- PAN card,
- Valid e-mail ID,
- Landline and Mobile Phone number,
- Affidavit and undertaking, as per **Annexure II (On ₹100 Stamp paper duly notarized)**
- Declaration by Bidder, as per **Annexure III, (On ₹100 Stamp paper duly notarized)**

Further, it should be noted that at any stage of the process, the Resolution Professional may ask for any documents from the prospective bidders to evaluate their eligibility. The Resolution Professional, at his discretion may disqualify the prospective bidder for non-submission of the requested documents.

H. PHYSICAL VERIFICATION AND SITE VISIT

1.1 The Qualified Bidder is expected to make its own arrangements including accommodation for the Site Visit. All costs and expenses incurred in relation to Site Visits shall be borne by the Qualified Bidder. The site visits by the qualified bidder may be carried on from 21st May, 2024 to 26th May, 2024 with prior approval from the Resolution Professional.

1.2 In Site Visit, the Qualified Bidder(s) may carry out its own comprehensive due diligence in respect of the Company and shall be deemed to have full knowledge of the condition of the Company, its assets, relevant documents, information etc. whether or not the Qualified Bidder actually inspects or participates in the Site Visit or verifies the document provided by the Resolution Professional. During the Site Visit, a Qualified Bidder shall not:

(i) Take any photographs of the Site or take any documents back with it; or

(ii) Initiate any discussion regarding the CIRP, with the personnel at Site, during the course of its Site Visit.

1.3 The Qualified Bidder shall not be entitled to receive any reimbursement of any expenses which may have been incurred in carrying out of due diligence and matters incidental thereto or for any purpose in connection with the Bid.

1.4 Any delay in completion of the Site Visit by the Qualified Bidder, shall not entitle the Qualified Bidder to any extension in the timelines, including the timeline for completion of such Site Visit or submission of the Bid, by or before the last date for submission of the Bid.

The Resolution Professional may coordinate a for inspection of Stock of Corporate Debtor for Eligible Bidders at any time from 21st May, 2024 to 26th May, 2024, following a request for such a visit by the Eligible Bidders. The Resolution Professional will communicate, in advance, to such Eligible Bidder, all the relevant details, terms and conditions, if any, with

respect to such Site Visit.

I. DUE DILIGENCE

The Resolution Professional shall endeavor to provide necessary assistance, facilitating the conduction of due diligence by interested Bidders. The information and documents shall be provided by the Resolution Professional in good faith.

The Resolution Professional shall endeavor to provide necessary assistance, facilitating the due diligence by Qualified Bidders. The information and documents shall be provided by the Resolution Professional in good faith.

The Resolution Professional proposes sale of the stock of the Corporate Debtor in accordance with the provisions of IBC and CIRP Regulations on "as is where is basis", "as is what is" and "whatever there is" basis and the proposed sale as specified above does not entail transfer of any title, except the title which the Company has on the assets as on date of the transfer. All local taxes / maintenance fee / electricity / water charges/ annual lease rentals / unearned income in case of leasehold assets, etc., outstanding as on date or yet to fall due in respect of the relevant asset should be ascertained by the Bidder and would be borne by the Successful Bidder. The cost of removing and loading/unloading will be borne by the buyer

It must also be noted that the Resolution Professional does not give any assurance or warranty of the physical condition of the stock and their suitability for any sort of operation that the bidder envisages.

J. EARNEST MONEY DEPOSIT

- a. All the Bidders shall provide, prior to submission of their E- Auction, the following amounts for bidding for the respective block (one or more as the case may be)

Block	Class	Reserve Price	Earnest Money Deposit	Incremental Value
I	Entire stock at the price sum of Finished Goods and Raw Materials	71,66,071.27	7,10,000.00	50,000.00
II	All Finished Goods	44,14,183.00	4,40,000.00	50,000.00
III	All Raw Materials	27,51,888.27	2,75,000.00	50,000.00

The complete list of stock is mentioned in **Annexure IV** of this complete process document. Kindly note that the bids received for Block I shall be given preference over Block II & III.

Further, kindly note that the EMD amount must be remitted in the account mentioned in clause J(b) before 27th May, 2024.

b. Mode of Payment of EMD and other instructions relating to EMD

- i. The EMD, which would not be bearing any interest, has to be paid by the Bidder prior to uploading the online Bid Application Form.
- ii. Through RTGS / NEFT to the account number of the Company as provided under:

Name	VIN SEMICONDUCTORS PRIVATE LIMITED CIRP ACCOUNT
Account No.	923020068296733
Bank Name	VASHI, MUMBAI, AXIS BANK LIMITED
IFSC Code	UTIB0000072

- iii. The details of any remittances in this regard shall be entered in the online form submitted by the Bidder. The entire amount shall be remitted by the Bidder(s) from one bank account only and to be owned by the Bidder.
- iv. Bidders shall preserve the remittance challan and shall produce the same in front of the Resolution professional as and when demanded.
- v. All the payments to be made by the Bidder under the e-auction shall be intimated to the Resolution professional at vinled.cirp@gmail.com with a copy to ipprashantjain@gmail.com

c. Forfeiture of Earnest Money Deposit from the Bidder

It is to be noted that the EMD furnished can be forfeited at any time, upon the

occurrence of any of the following events:

- (i) if there is a breach of any of the conditions under this Detailed Sale Process Document (Sale of Stock of the Corporate Debtor) by the Bidder or in case Bidder is found to have made any misrepresentation or fraud; or
- (ii) if Bidder is found to be ineligible to submit the Bid as per the conditions set out in Section 29A of the IBC (as amended from time to time) or is found to have made a false or misleading declaration of eligibility as per the conditions set out in Section 29A of the IBC (as amended from time to time); or
- (iii) if the Successful Bidder after being intimated by the Resolution professional as Successful Bidder, fails to make the complete payment within the time stipulated in the CIRP Regulations as per the terms of letter of intent issued by the Resolution professional.
- (iv) In case of any of the above event, all the amounts deposited till that date shall be forfeited and the option to acquire the stock of the Company / Company will be offered to the next highest Bidder.

d. Other terms

- i. The Bid once submitted cannot be withdrawn and in case of non-participation in E-Auction after submission of Bid, the offer will be presumed to be given at Reserve Price. The E-Auction Service Provider shall itself register the Bidder in E-Auction in such event.
- ii. In case the E-Auction fails, then the EMD paid by the Bidder shall be returned (without interest) to such applicant within 15 (fifteen) days of the date of closure of E-Auction Process.
- iii. For Successful Bidders, an email confirmation will be given for being Successful Bidder on the 5th June, 2024

K. LETTER OF INTENT

- a. The Successful Bidder shall be required to execute a LOI provided by the Resolution professional within a period of 5 days from declaration as successful bidder, and

record unconditional acceptance of the LOI by providing the Resolution professional with one copy of LOI with an endorsement stating that LOI is accepted unconditionally under the signature of the representative of the Successful Bidder.

L. PAYMENT OF 1st INSTALLMENT

- a. The successful bidder shall be required to submit a further consideration for an amount equal to 25% of the bid amount after adjusting EMD with respect, within 5 days from declaration as successful bidder by the Resolution professional.
- b. Mode of Payment of 1st Installment**
- c. The 1st Installment, which would not be bearing any interest, has to be paid by the Bidder within 5 days from declaration as successful bidder by the Resolution professional.
- d. Through RTGS / NEFT to the account number of the Company as provided under:

Name	VIN SEMICONDUCTORS PRIVATE LIMITED CIRP ACCOUNT
Account No.	923020068296733
Bank Name	VASHI, MUMBAI, AXIS BANK LIMITED
IFSC Code	UTIB0000072

- i. The details of any remittances in this regard shall be entered in the online form submitted by the Bidder. The entire amount shall be remitted by the Bidder(s) from one bank account only and to be owned by the Bidder.
- ii. Bidders shall preserve the remittance challan and shall produce the same in front of the Resolution professional as and when demanded.

e. Forfeiture of 1st Installment of Payment from the Bidder

It is to be noted that the 1st Installment of Payment furnished can be forfeited at any time, upon the occurrence of any of the following events:

- i. if there is a breach of any of the conditions under this Detailed Sale Process

- Document (Sale of stock of the Corporate Debtor) by the Bidder or in case Bidder is found to have made any misrepresentation or fraud; or
- ii. if Bidder is found to be ineligible to submit the Bid as per the conditions set out in Section 29A of the IBC (as amended from time to time) or is found to have made a false or misleading declaration of eligibility as per the conditions set out in Section 29A of the IBC (as amended from time to time); or
 - iii. In case of any of the above event, all the amounts deposited till that date shall be forfeited and the option to acquire the stock of the Company / Company will be offered to the next highest Bidder.

M.SET-OFF OF EMD AND BALANCE PAYMENT

- a. The balance towards the 100% consideration shall be deposited within 30 days from the issuance of Letter of Intent by the Resolution professional
- b. Unless expressly indicated by the Bidder, the EMD and 1st Installment shall be set-off against or used as part of the consideration that the Successful Bidder proposes to offer as a sale consideration for the Company.

N. DEFAULT BY SUCCESSFUL BIDDER AND ITS CONSEQUENCES

- a. In the event that the Successful Bidder withdraws his Bid Application Form, the Resolution professional shall have the right to invoke the EMD, and also invoke the 1st Installment of Payment furnished by the Successful Bidder.
- b. If the Successful Bidder does not furnish the balance consideration pursuant to the LOI issued by the Resolution professional within the timelines stipulated under this process document, the Resolution professional shall have the right to invoke the EMD and also invoke the 1st Installment of Payment and any other payment furnished by the Successful Bidder.

O. DECLARATION OF SUCCESSFUL BIDDER

The Successful Bidder(s) shall be determined on the basis of highest Bid received and in discussion with the COC Members. This right of selecting and declaring the Successful Bidder(s) shall always solely rest with the Resolution professional & COC Members.

P. FRAUDULENT AND CORRUPT PRACTICES

The Bidder shall observe the highest standard of ethics during Application and subsequently during the closure of the Process and declaration of successful bidder. Notwithstanding anything to the contrary contained in this Process Document, or in the Letter of Intent, the Resolution Professional shall reject a bid, revoke the Letter of Intent, as the case may be, without being liable in any manner whatsoever to the bidder, if the Resolution Professional, at his discretion, determines that the bidder has, directly or indirectly or through an agent, engaged in corrupt practice, fraudulent practice, coercive practice, undesirable practice or restrictive practice in the Process or has, undertaken any action in respect of such process which results in the breach of any Applicable Law including the Prevention of Corruption Act, 1988. In such an event, the Resolution Professional may invoke the Earnest Money, without prejudice to any other right or remedy that may be available to the Resolution Professional under this Process Document or Applicable Law.

For the purposes of this Clause, the following terms shall have the meaning hereinafter respectively assigned to them:

“**Coercive practice**” shall mean impairing or harming, or threatening to impair or harm, directly or indirectly, any person or property to influence any person’s participation or action in the sale of the property; “**corrupt practice**” shall mean

- a) the offering, giving, receiving, or soliciting, directly or indirectly, of anything of value to influence the actions of any person connected with the sale of the property (for avoidance of doubt, offering of employment to or employing or engaging in any manner whatsoever, directly or indirectly, any official of the Resolution Professional or the Company, who is or has been associated or dealt in any manner, directly or indirectly with the auction Process or arising there from, before or after the execution thereof, at any time prior to the expiry of 1 (one) year from the date such official resigns or retires from or otherwise ceases to be in the service of the Resolution Professional or the Company, shall be deemed to constitute influencing the actions of a person connected with the sale of the property);
or
- b) engaging in any manner whatsoever, during the auction Process or thereafter, any person in respect of any matter relating to the Company, who at any time has been or is a legal, financial or technical adviser of the Resolution Professional or the Company, in relation to any matter concerning the invitation for sale of the property process;

“**fraudulent practice**” shall mean a misrepresentation or omission of facts or

suppression of facts or disclosure of incomplete facts, in order to influence the invitation for sale of the Stock process;

“restrictive practice” shall mean forming a cartel or arriving at any understanding or arrangement among the sale of the property of Applicant with the objective of restricting or manipulating a full and fair competition in the invitation for sale of the property process; and

“undesirable practice” shall mean (i) establishing contact with any person connected with or employed or engaged by the Resolution Professional with the objective of canvassing, lobbying or in any manner influencing or attempting to influence the invitation for sale of the property process; or (ii) having a Conflict of Interest.

The Bidder shall not involve himself for any of his representatives in price manipulation of any kind directly or indirectly by communicating with other Bidders.

The Bidder shall not divulge either his bid or any other details provided to him by the Resolution Professional or during the due diligence process in respect of the asset to any other party. Prior to conduct of due diligence / site visits, the Resolution Professional may require the Bidder to execute confidentiality agreement with the Company / Resolution Professional.

Q. COSTS, EXPENSES AND TAX IMPLICATIONS

The invitation for sale of the Stock process, applicant / bidder shall be responsible for all the costs incurred by it on account of its participation in the invitation for sale of the Stock, including any costs associated with participation in the discussion Meeting (if any), Site Visit, etc. The Resolution Professional shall not be responsible in any way for such costs, regardless of the conduct or outcome of the invitation for sale of the Stock Process.

It is hereby clarified that the invitation for sale of the Stock Process, Applicant shall make its own arrangements including accommodation for the discussion Meeting (if organized), Site Visit, due diligence and all costs and expenses incurred in that relation shall be borne by the Bidder.

The bidder shall not be entitled to receive any re-imburement of any expenses which may have been incurred while carrying out the due diligence and matters incidental thereto or for any purpose in connection with the invitation for the sale of the sale of the Stock.

It is to be noted that all taxes applicable on sale of Stock (Finished good and Raw materials) would be borne by the successful bidder:

1. The successful bidder shall bear all the necessary expenses i.e., taxes and charges for loading and unloading the stock in his / her name

It is expressly stated that the Resolution Professional does not take or assume any responsibility for any minor dues or otherwise, of the Company, including such dues, if any, which may affect transfer of the CIRP assets in the name of the Successful Bidder and such dues, if any, will have to be borne / paid by the Successful Bidder.

The invitation for the sale of the Stock process, applicant shall be responsible for fully satisfying the requirements of the IBC and the related Regulations as well as all Applicable Laws that are relevant for the sale process.

R. GOVERNING LAW AND JURISDICTION

This Process document shall be governed by the laws of India and any dispute arising out of or in relation to the sale of the property or the sale Process shall be subject to the exclusive jurisdiction of the Adjudicating Authority, courts and tribunals at Mumbai, India.

S. TIMETABLE

The following timetable shall apply to the Invitation for Bid of sale of property Process Information Document. The timetable may be amended by the Resolution Professional through issuance of an addendum to the sale of property Process Information Document.

Sr. No.	Event	Date
1.	Publication of notice	9 th May, 2024
2.	Last date for submission of Expression of Interest	20 th May, 2024
3.	Inspection by bidders	21 st May, 2024 to 26 th May 2024
4.	Last date for submission of EMD	27 th May, 2024
5.	Auction	29 th May, 2024
6.	Communication of Confirmation to H1 Bidder	5 th May,2024

Note –

The timeline for payment of complete payment may be extended at the sole discretion of Resolution Professional, to the extent permissible under the applicable laws and regulations. In case the total payment of bid amount is not paid within the timeline, the Resolution Professional shall forfeit EMD.

ANNEXURE – I
BID APPLICATION FORM

(Please fill up separate Bid application form)

(Should be in company letter head and notarized)

Date:

To

Mr. CA Prashant Jain

Resolution Professional of Vin Semiconductors Private Limited

Registration No. IBBI/IPA-001/IP-P01368/2018-2019/12131

Address: B-610, BSEL Tech Park, Plot No.39/5 & 39/5A, Sector 30A, Vashi NA Navi

Mumbai, Mumbai City, Maharashtra 400703

Dear Sir,

I am desirous in participating in the E-Auction announced by you in the newspaper publication dated..... In (name of media journal).

Details of Corporate Debtor

Name	VIN SEMICONDUCTORS PRIVATE LIMITED CIRP ACCOUNT
Account No.	923020068296733
Bank Name	VASHI, MUMBAI, AXIS BANK LIMITED
IFSC Code	UTIB0000072

Details of Bidder / Bid Price Offered

Name of the Bidder	
Constitution of Bidder	
Contact No.	
Email ID	
PAN No.	
Address	
Account Number	
Bank Name	
Branch	
Address	
Block of Asset (stock) to bid	

Details of bank and branch in which refund has to be made:-

Bank account no.	
Name of Bank	
IFSC Code	
Branch Name	

I/We/M/s. also enclose copies of the required KYC documents. We request you to kindly verify the same and arrange with the auction portals for issue of an ID and password for us to enable us to take part in the E-Auction.

We have read and understood all the terms and condition mentioned in the E-Auction Document.

Place:

On behalf of the Bidder

Date:

ANNEXURE II
AFFIDAVIT AND UNDERTAKING

Date: _____

To,

Mr. Prashant Jain

The Resolution Professional of,

Vin Semiconductors Private Limited

Undergoing Corporate Insolvency Resolution Process (CIRP)

Address – 610, B Wing, BSEL Tech Park, Sector 30A, Opposite Vashi Railway Station, Vashi, Navi Mumbai – 400 705 (MH)

Sub – Disclosure of eligibility under section 29A of the Insolvency and Bankruptcy Code, 2016 and declaration for submitting bid for the sale of the property.

Dear Sir,

A. I hereby submit this declaration under Section 29A of the Insolvency and Bankruptcy Code, 2016 (“Code”) as inserted by the Insolvency and Bankruptcy Code (Amendment) Act, 2018:

I have understood the provisions of section 29A of the Insolvency and Bankruptcy Code, 2016. I confirm that neither _____ (Bidder) nor any person acting jointly with _____ (Bidder) or any person who is a promoter or in the management or control of _____ (Bidder) or any person acting jointly with _____ (Bidder):

- a) is an un-discharged insolvent;
- b) is a willful defaulter in accordance with the guidelines of the Reserve Bank of India issued under the Banking Regulation Act, 1949;
- c) has an account, or an account of a corporate debtor under the management or control of such person or of whom such person is a promoter, classified as non-performing asset in accordance with the guidelines of the Reserve Bank of India issued under the Banking Regulation Act, 1949 or the guidelines of a financial sector regulator issued under any other law for the time being in force and at least a period of one year has lapsed from the date of such classification till the date of commencement of the corporate insolvency resolution process of the corporate debtor;
- d) has been convicted for any offence punishable with imprisonment:
 - for two years or more under any Act specified under the Twelfth Schedule;
 - for seven years or more under any law for the time being in

force:

- e) is disqualified to act as a director under the Companies Act, 2013;
- f) is prohibited by the Securities and Exchange Board of India (SEBI) from trading in securities or accessing the securities markets;
- g) has been a promoter or in the management or control of a corporate debtor in which a preferential transaction, undervalued transaction, extortionate credit transaction or fraudulent transaction has taken place and in respect of which an order has been made by the Adjudicating Authority under this Code;
- h) has executed an guarantee in favour of a creditor in respect of a corporate debtor against which an application for insolvency resolution made by such creditor has been admitted under this Code;
- i) is subject to any disability, corresponding to clauses (a) to (h) of Section 29A, under any law in a jurisdiction outside India; or
- j) has a connected person (as defined in Explanation to Section 29A) who is ineligible under clauses (a) to (i) of Section 29A.

I therefore, confirm that _____ (Bidder) is eligible to be bidder in accordance to Section 29A of the Insolvency and Bankruptcy Code, 2016 (“Code”) as inserted by the Insolvency and Bankruptcy Code (Amendment) Act, 2018.

- B. I undertake on behalf of _____ (Bidder), that during the CIRP Process, no person who would be considered as Connected Person and is not eligible to submit resolution plan under section 29A of Insolvency and Bankruptcy Code, 2016 and the regulation 38 of IBBI (Insolvency Resolution Process of Corporate Persons) regulations, 2016 shall be engaged in the management and control of corporate debtor.
- C. I declare and undertake that in case the _____ (Bidder) becomes ineligible at any stage during the CIRP Process, it would inform the Resolution Professional forthwith on becoming ineligible.
- D. I also undertake that in case the _____ (Bidder) becomes ineligible at any time after submission of the EMD, then the EMD would be forfeited and the same would be deposited in the account of Vin Semiconductors Private Limited – in CIRP.
- E. I also further undertake that my winning bid Amount will remain binding unless rejected by the Resolution Professional.
- F. I confirm that the said declaration and disclosure is true and correct.

G. I am duly authorized to submit this declaration by virtue of
_____.

(DEPONENT)

VERIFICATION

I, the deponent above, do hereby solemnly declare and affirm that the above statement given by me is true and correct to the best of my knowledge and belief and nothing stated above is false or misrepresentation or misleading.

(DEPONENT)

Terms and Conditions of the E-Auction are as under:
(To be on a judicial stamp paper of Rs.100 and should be notarized)

In addition to the Detailed Sale Process Document (Sale of Stock of the Corporate Debtor), following terms and conditions apply:

1. -Auction is being held on **“AS IS WHERE IS”, AND “NO RECOURSE” BASIS** and will be conducted **“Online”**. The E-Auction will be conducted through the approved service provider Linkstar Infosys Private Limited from the website <https://eauctions.co.in>.
2. The Complete E-Auction Process document containing Undertaking, E-Auction bid form, Declaration by bidders, General terms and conditions of online auction sales are available on Website: www.ssarvi.com.
3. The intending bidders, prior to submitting their bid, should make their independent inquiries regarding dues of local taxes, electricity and water charges, maintenance charges, if any and inspect the property at their own expenses and satisfy themselves. Further they have to make their own verification and due diligence of the details of the assets.
4. The resolution professional is conducting this auction as per the provision of law. In this regard the bidder is agreeing to the fact that the said auction is related to the information available with the resolution professional. However, the bidder will conduct their own due diligence with the local authority. In case of any discrepancy the resolution professional reserves her right to cancel the auction for the said block.
5. The E-Auction advertisement does not constitute and will not be deemed to constitute any commitment or any representation of the resolution professional. The property is being sold with all the existing and future encumbrances/claims/dues/demands whether known or unknown to the resolution professional. resolution professional shall not be responsible in any of way for any third-party claims/ rights/ dues.
6. It should be the responsibility of the interested bidders to inspect and satisfy themselves about the property before submission of the bid.
7. The intending bidders are required to deposit Earnest Money Deposit (EMD) amount either

through NEFT/RTGS in the Account of “VIN SEMICONDUCTORS PRIVATE LIMITED”, in the account mentioned above.

8. The intending bidder should submit Request Letter for participation in the E- Auction along with Self attested copy of (1) Proof of Identification (2) Current Address-Proof (3) PAN card (4) Valid e-mail ID (5) Landline and Mobile Phone number (6) Bid Application Form as per Annexure I (7) Affidavit and Undertaking, as per Annexure II (8) Declaration by Bidder, as per Annexure III, the formats of these Annexures can be taken from the Complete E-Auction process document.
9. GST and all other applicable charges will be borne by the bidder. However, GST will be charged as per the provision of GST act and will be provided in Letter of Intent that will be issued to the H1 bidder.
10. This term and condition are with reference to transfer any asset which requires transfer of ownership. In this regard, the resolution professional will like to mention that the process of ownership transfer will start only after the resolution professional receives full consideration as per Letter of intent issue to the bidder as per the provision of IBC 2016. However, any delay in such transfer from the side of resolution professional or any appropriate transfer authority cannot be taken as a ground for cancelation of bidding form the side of Successful Bidder.
11. Resolution Professional has right to demand documents from bidder for the process and in case the documents are not provided, the Resolution Professional may disqualify the bid.
12. In case, a bid is placed in the last 5 minutes of the closing time of the e-auction, the closing time will automatically get extended for 10 minutes with unlimited extension. The bidder who submits the highest bid amount (not below the reserve price) on closure of e-Auction process shall be declared as the Successful Bidder and a communication to that effect will be issued through electronic mode which shall be subject to approval by the Resolution Professional.
13. The EMD of the Successful Bidder shall be retained towards part sale consideration and the EMD of unsuccessful bidders shall be refunded. The EMD of unsuccessful bidders

shall be refunded within fifteen working days after the date of E-Auction.

14. The EMD shall not bear any interest. The Resolution Professional will issue a Letter of Intent (LOI) to the Successful Bidder and the Successful Bidder shall have to deposit the balance amount (Successful Bid Amount – EMD Amount) within 30 days from the issuance of the LOI by the Resolution Professional. Default in deposit of the balance amount by the successful bidder within the time limit as mentioned in the LOI would entail forfeiture of the entire amount deposited (EMD + Any Other Amount) by the Successful Bidder.
15. The Successful Bidder shall bear the applicable stamp duties/transfer charge, fees etc. and all the local taxes, duties, rates, assessment charges, fees etc. in respect of the property put on auction. With reference to auction put on sold any type of transportation, dismantling cost or any other related cost shall be borne by the successful bidder.
16. The Resolution Professional is not liable or bound to accept the highest offer or the highest bid and has the absolute right to accept or reject any or all offer(s) or adjourn/postpone/cancel the e-Auction or withdraw any property or portion thereof from the auction proceeding at any stage without assigning any reason thereof.
17. The sale shall be subject to conditions and provisions under Insolvency and bankruptcy code, 2016 and regulations made thereunder.
18. If in case, not more than one bidder deposits the EMD, then in that case the Resolution Professional will have the absolute power to cancel the auction process after the consultation with the stakeholders.
19. The decision of the Resolution Professional on declaration of Successful Bidder shall be final and binding on all the Bidders.
20. The requisition of additional information, if any, be sent to vinled.cirp@gmail.com with a copy to ipprashantjain@gmail.com disclosing the identity of the Applicant.

21. The Bidders should make their own independent inquiries regarding the encumbrances on auction and claims/rights/dues/ affecting the assets of the Company and should conduct their own due diligence prior to submitting their Bid. The e-Auction advertisement does not constitute and will not be deemed to constitute any commitment or any representation of the Resolution Professional. The stock of the Company is proposed to be sold with all the existing and future encumbrances/claims/dues/demands whether known or unknown to the Resolution Professional. Resolution Professional shall not be responsible in any of way for any third- party claims/ rights/ dues.
22. The Bidders should submit the request letter for participation in E-Auction as follows:
- (i) In case of individuals: (a) Proof of identification (KYC) viz. Voter ID card/ Driving License/ Passport etc., (b) Current Address-Proof for communication, (c) PAN card of Bidder, (d) Valid Email ID, (e) contact number (Mobile/Landline) (f) and all other relevant documentation in relation to the bidding process.
 - (ii) In case the Bidder is a Company/Entity: (a) Copy of original authorization letter at company letter head, in the name of the individual authorized to collect Letter of Intent on behalf of the company; (b) Copy of ID Proof of the authorized representative like AADHAR/Passport etc; (c) Copy of PAN Card of the Company; (d) Copy of Memorandum and Articles of Association of the company; and (e) All relevant documentation related to the E-Auction Process to the office of the Resolution Professional. Scanned copies of the original of these documents can also be submitted to the email of the Resolution Professional at sent to vinled.cirp@gmail.com with a copy to ipprashantjain@gmail.com
 - (iii) At the time of delivery, the authorized person would have to show the original documents of: (i) Original authorization letter of the Company; (ii) Original ID Proof of the authorized representative/Individual appearing like AADHAR/Passport etc. and (iii) Original PAN Card of the Company/ Individual.
23. Name of the Prospective Bidders will be identified and conveyed by Resolution Professional to participate in online E-Auction on the portal as per timelines specified in the Detailed Sale Process Document (Sale of Stock of the Corporate Debtor). The

Prospective Bidder shall be required to be registered with the E- Auction Service Provider for generation of login credentials to enable the prospective Bidder to participate in the E- Auction.

24. It should be the responsibility of the Prospective/Interested Bidders to inspect and satisfy themselves about the assets of the Company / Company before submission of the Bid.
25. Resolution Professional has right to demand any additional documents from the Bidder for the E- Auction Process. In case such additional documents are not provided by the Bidder, the Resolution Professional in his own discretion may disqualify the Bid.
26. The E-Auction of the Company would be conducted on 29th May, 2024
27. The EMD of unsuccessful bidders shall be refunded within fifteen days from the date of E- Auction. The EMD shall not bear any interest.
28. In case of the Successful Bidders, the EMD and 1st Installment of Payment received shall be adjusted towards the balance sale consideration.
29. The Resolution Professional will intimate through mail to the Successful Bidder, detailing the total payable amount for consummating the sale of the Company and other terms and conditions. The Successful Bidder would have to pay the balance sale consideration.
30. Amount less EMD for the sale of the Company within time stipulated in this E- Auction Process Information Document. Any default in payment of the bid amount by the Successful Bidder would entail forfeiture of EMD and 1st Installment already deposited the Company shall be put to re-auction and the defaulting Bidder shall have no claim / right in respect of Company / amount paid whatsoever.
31. The Successful Bidder shall bear the applicable stamp duties/ additional stamp duty / transfer charges, fee, taxes, Good and Services Tax, etc. and also all the statutory/ non-statutory dues, taxes, rates assessment charges fees etc. owing to anybody.
32. The Resolution Professional is not bound to accept the highest offer or and has the absolute

right to accept or reject any or all offer(s) or adjourn / postpone/ cancel the E-Auction or withdraw any asset or portion thereof from the e-auction proceedings at any stage without assigning any reason there for.

33. The sale certificate will be issued and / or transaction / sale documents executed in the name of Successful Bidder(s) only and will not be issued in any other name(s).
34. The sale of the Company as contemplated under this document shall be subject to conditions prescribed under the Insolvency & Bankruptcy Code, 2016 read with amendments and rules/ regulations made thereunder.
35. The Bidder may submit his offer as per the process specified in Detailed Sale Process Document (Sale of Stock of the Corporate Debtor).
36. The decision of the Resolution Professional on declaration of Successful Bidder shall be final and binding on all the Bidders.
37. The Bidders are required to keep themselves updated for any revisions in the terms and conditions of E-Auction by regularly visiting the links and website addresses of the Company as mentioned in this Detailed Sale Process Document (Sale of Stock of the Corporate Debtor).

Date: _____

Place: Mumbai

Sd/-

CA Prashant Jain

Resolution Professional in the matter of Vin Semiconductors Private Limited.

Partner, SSARVI Resolution Services LLP

Reg. No.: IBBI/IPA-001/IP-P01368/2018-2019/12131

Contact Details of Office:

Address: B-610, BSEL Tech Park, Plot No.39/5 & 39/5A, Sector 30A, Vashi NA Navi

Mumbai, Mumbai City, Maharashtra 400703

(Mr. CA Prashant Jain is a Registered Insolvency Professional with Insolvency and Bankruptcy Board of India (“IBBI”). His Registration number is IBBI/IPA-001/IP-P01368/2018-2019/12131. Mr. CA Prashant Jain has been appointed as a Resolution Professional of Vin Semiconductors Private Limited by NCLT, Mumbai Bench, vide its order dated 10th November, 2023. The affairs and property of Vin Semiconductors Private Limited are being managed by the Resolution Professional, Mr. CA Prashant Jain.)

ANNEXURE – III
Declaration by Bidders

To,

Mr. Prashant Jain

The Resolution Professional of,

Vin Semiconductors Private Limited

Undergoing Corporate Insolvency Resolution Process (CIRP).

Dear Sir,

1. I / We, the Bidder (s) aforesaid do hereby state that, I / We have read the Notice of Invitation of Bid and the complete process document and have understood them fully. I / We, hereby unconditionally agree to confirm with and to be bound by the said terms and conditions and agree to take part in the bidding.
2. I / We declare that the Earnest Money Deposit (EMD) and the deposit towards purchase-price have been made by me / us as against my/our bid and that the particulars of remittance and all other information given by me/us is true and correct.
3. I / We further understand and agree that if any of the statement / information revealed by me / us is found to be incorrect and / or untrue, the bid submitted by me / us is liable to be cancelled and in such case, the EMD and / or any monies paid by me / us is liable to be forfeited by the Seller (“Resolution Professional”) and the Seller will be at liberty to annul the offer made to me/us at any point of time.
4. I / We also agree that after my /our offer given in my /our bid for purchase of property (ies) is accepted by the Seller and if, I / We, fail to accept or act upon the terms and conditions of the sale or am / are not able to complete the transaction within the time limit specified for any reason whatsoever and /or fail to fulfil any / all the terms and conditions of the auction and offer letter, the EMD and other monies paid by me / us along with the online form and thereafter, are liable to be forfeited. The timeline for payment of final sale consideration may be extended by sole discretion of Resolution Professional, to the extent permissible under the applicable laws and regulations. In case final sale consideration is not paid within timeline, the Resolution Professional shall forfeit EMD and or Performance BG.
5. I / We understand that the EMD of all Bidders shall be retained by the Resolution Professional and returned only after the successful conclusion of

the sale of property. I / We, state that I / We, have fully understood the terms and conditions therein and agree to be bound by the same.

6. I / We confirm that our participation in the bidding, submission of bid or acquisition of the property pursuant to the provisions of the Information Document will not conflict with, or result in a breach of, or constitute a default under (i) our constitutional documents; or (ii) any applicable laws; or (iii) any authorization or approval of any government agency or body; or (iv) any judgement, order, injunction, decree, or ruling of any court or governmental authority, domestic or foreign binding on me / us; or (v) any agreement to which I am / we are a party or by which I am / We are bound.
7. The decision taken by the Resolution Professional with respect to the selection of the Successful bidder and communicated to us shall be binding on me/us.
8. I/We also undertake to abide by the additional conditions if announced during the bidding including any announcement(s) on correction of and / or additions or deletions to the time of website portal and property (ies) being offered for sale.
9. I/We hereby confirm that I/we are eligible to purchase the stock of the Company under Section 29A of the Insolvency and Bankruptcy Code, 2016.

(Signature with SEAL)

Name:

Address:

.....

Email:.....

Mobile:.....

ENCLOSURES:

- Proof of Identification,
- Current Address-Proof,
- PAN card,
- Valid e-mail ID,
- Landline and Mobile Phone number,

ANNEXURE – IV
DESCRIPTION OF THE STOCK

(Note: - The list attached herewith is for reference the physical condition may differ. The items mentioned below are provided on "as is where is basis", "as is what is" basis, "whatever there is" basis and "no recourse" basis)

I. Details of the Finished Goods:

Sr No.	Item Name	Colour	Qty.
1	SLP - 3	WHITE	1013
2	SLP - 6	WHITE	145
3	SLP - 3	NEUTRAL WHITE	410
4	SLP - 6	NEUTRAL WHITE	307
5	SLP - 3	WARM WHITE	63
6	SLP - 6	WARM WHITE	94
7	SF - 15 ROUND		52
8	RLP - 3	WHITE	250
9	RLP - 3	WARM WHITE	101
10	RLP - 3	NEUTRAL WHITE	67
11	RLP - 6	WHITE	22
12	RLP - 6	NEUTRAL WHITE	133
13	RLP - 6	WARM WHITE	84
14	LED STRIP LIGHT - 25W	WHITE	20
15	LED STRIP LIGHT - 25W	NEUTRAL WHITE	39
16	LED STRIP LIGHT - 25W	WARM WHITE	136
17	LED STRIP LIGHT - 25W	WARM WHITE	25
18	LED STRIP LIGHT - 10W	WHITE	28
21	SF - 6 ROUND	WHITE	163
22	DSL - 3W	WHITE	64
23	RLP - 18	NEUTRAL WHITE	456

24	RLP - 18	WARM WHITE	108
25	RLP - 9	WHITE	147
26	DSL - 3	WHITE	1200
27	DSL - 12	WHITE	857
28	FLP - 10	WHITE	164
29	FLP - 20	WHITE	13
30	FLP - 10	WHITE	34
31	DYNALITE-M 3W	WHITE	1
32	SF-12 (SQUARE)	WHITE	81
33	SF-12 (SQUARE)	WW	49
34	SQ-6	WHITE	28
35	SQ-12	NW	126
36	SF-15	WW	27
37	SF-12	NW	40
38	SF-12	WHITE	40
39	SF-18	WW	62
40	SF-18	NW	63
41	SF-18	WHITE	2
42	SF-18	WW	104
43	SQ-6	WHITE	169
44	SQ-6	WW	62
45	SQ-6	NW	23
46	SF-12 (ROUND)	WHITE	7
47	SF-12 (ROUND)	NW	61
48	SF-18	NW	19
49	SQ-6	NW	20
50	SQ-6	WW	16
51	SF-18 (ROUND)	NW	30
52	SF-18 (ROUND)	WHITE	72
53	SF-18 (ROUND)	NW	16
54	SF-18 (ROUND)	WW	84
55	DYNALITE - 5W (ROUND)	WHITE	90
56	DYNALITE - M5	WHITE	175
57	DYNALITE - M5	WW	43
58	DYNALITE - M3	WHITE	121
59	DYNALITE - M3	WW	230
60	CUBIX 40W		61
61	LED 12W SPOT LIGHT	WHITE	51
62	LED 12W SPOT LIGHT	WW	6
63	LED 12W SPOT LIGHT	NW	13
64	DYNALITE - M5		41
65	DYNALITE - 5	WHITE	49
66	DYNALITE - M5	WHITE	151
67	L - 5	WHITE	40

68	L - 5	WARM WHITE	10
69	L - 8	WHITE	24
70	L - 8	NEUTRAL WHITE	25
71	L - 8	WARM WHITE	25
72	L - 5	WHITE	50
73	L-22	NEUTRAL WHITE	40
74	L-22	WHITE	24
75	DS - 9 TUBELIGHT	WHITE	35
76	L - 22	WARM WHITE	15
77	L- 5	NEUTRAL WHITE	17
78	L- 5	WHITE	2
79	ESP - 18 TUBELIGHT	WHITE	18
80	ERP - 18 TUBELIGHT	WHITE	10
81	DR-18 TUBELIGHT	NEUTRAL WHITE	25
82	ESP - 18 TUBELIGHT	NEUTRAL WHITE	15
83	ESP - 18	WARM WHITE	22
84	ER- 18	WARM WHITE	84
85	ESP - 18	WHITE	134
86	PLATO LINEAR LIGHT		370
87	ES - 9W 2FT		75
88	T5 - 19 TUBELIGHT	WHITE	12
89	T5 - 19 TUBELIGHT	WHITE	46
90	TR-9 2FT TUBELIGHT	WARM WHITE	102
91	ES- 9 TUBELIGHT	WARM WHITE	104
92	T8 - FT 92 2FT	WHITE	145
93	ES- 18 TUBELIGHT	WHITE	2464
94	ER - 18 TUBELIGHT ALUMINIUM	WHITE	527
95	T-8 TUBELIGHT	WHITE	197
96	I - 22 TUBELIGHT	WHITE	14
97	I - 40	WHITE	26
98	ERP - 18 TUBELIGHT	WHITE	510
99	ERP - 18	WHITE	279
100	ERP - 18 TUBELIGHT	WHITE	143
101	ES- 22 36 W	WHITE	49

102	CELIO - 5	WHITE	59
103	CELIO - 8	WHITE	76
104	LED STRIP LITE FLEXOLITE- (5MTR/ROLL)	WARM WHITE	13
105	LED STRIP LITE FLEXOLITE - (5 MTR/ROLL)	WHITE	9
106	LED STRIP	WARM WHITE	14
107	LED FLEXIBLE STRIP	WHITE	47
108	LED FLEXIBLE STRIP	WARM WHITE	26
109	SF6 SURFACE PANEL LIGHT	WARM WHITE	25
110	MICRO SENSOR 18W TUBELIGHT	WHITE	76
111	ES - 18	WHITE	29
112	ES - 18	WHITE	31
113	MOTION SENSOR VIN 18 TUBE	WHITE	16
114	L-15	White	22
115	L-15	Warm White	38
116	L-15	Neutral White	22
117	JL - 12	WARM WHITE	47
118	JL - 12	WHITE	21
126	(RELIO SERIES) 12/60 PSWP	NA	55
127	12/100 PSWP	NA	100
132	12/350 PSNW LRS MW	NA	45
133	12/120 PSNW (RELIO)	NA	240
134	12/200 PSNW (RELIO)	NA	72
135	12/400 PSNW (RELIO)	NA	179
338	UFO - 150	WHITE	12
339	UFO - 150	WHITE	20
490	ES-22 36W	WHITE	42
491	CUBIX 36W		11
495	ES-22		19
503	F - 200		81
546	STL - 30	WHITE	56
548	NACTUS NX 150		20
901	UFO - 150 WATT	WHITE	23
907	APOLLO - 25	WARM WHITE	23

II. Details of the Raw Materials:

Sr No.	Item Name	Qty.
1	BKL Round Fixture	28
2	Power Supply Side Cap Plastic Cover(old) scrap	100
3	9 Watt Bulb Power Supply	25
4	Buffing Wheel	100
5	Catting Wheel	135
6	L-15, Packing Box	125
7	Gold Bar End Cap	1635
8	GL 6 Aluminium Fixture part	50
9	Connector, Male - Female	80
10	L-5, Connector Male - Female	2000
11	L-15, Connector Male - Female	1500
12	Gold Bar Connector Male - Female	205
13	SLP-RLP, Male - Female Connector	150
14	2A Connector Male - Female	150
15	BOLARD LIGHT ONLY TOP WARM WHITE ALUM. DOME	39
16	SL9 Fixture	40
17	SL8 Fixture	25
18	100 Watt Bulb Heatsink	23
19	2A Connector (L15/L22- MR Connector)	150
20	3 Way Connector	3000
21	SQ 18 Front Fixture	39
22	SLP 3, Fixture	305
23	Door Magnet	150
24	Gold Bar Clip (Side Clip)	5000
25	SLP-RLP Connector	4843
26	3 Way Connector WP	1850
27	1 Way Connector (White)	1150
28	1 Way Connector (Black)	50
29	Lenox 1 RWIN Blade Benso	6
30	Video Wall Connector	50
31	BOLARD 5W WARM WHITE READY TOP	13
32	Bay star Reflector Aluminum	177

33	IGS Spot Light - 3V Reflector Aluminium	40
34	GL6 Spot Light Top cover Fixture part	50
35	SL 9 End Cap SS (scrap)	316
36	Old Spot Light fixture part Plated	500
37	Goldbar Side Cap	1530
38	ESP 18 SS (Mounting Clamp) import	11320
39	Tubelight End Cap old mix stock	3830
40	ESP 18 (Mounting Clamp), PVC	550
41	IGDR Side Clamp clamp scrap	335
42	U Clamp for House wiring pipe feeting	100
43	GDR Mounting Ring alum. Scrap	50
44	3 Nos Packing Box	20
45	Wall Washer Paking Box	100
46	Bay Star Paking Box	120
47	PTX Paking Box	160
48	Cubix Fixture	48
49	Tubelight Packing OUTER Box	80
50	Liner Light Profile 5073 10 feet PC diffuser ONLY	70
51	Liner Light Profile 5073 2 Feet PC Diffuser ONLY	50
52	Alpha Wall Washer, RGB-PVC, 36 LED MCPCB	40
53	Gold Bar PCB scrap	110
54	Alpha PCB- RGBW	3
55	Alpha RGB, 36 LED	4
56	ES18- PCB, T5 Tubelight PCB	1182
57	GL9, PCB	80
58	FR 60 With 30LED	4
59	FR GBW PCB 3535, 40 LED	9
60	Matrix 120 Watt, PCB - 104 LED	5
61	FLC - 22, 10 LED, PCB	40
62	LM6, PCB - 6 LED, 3535 scrap	35
63	FLP - 32, PCB	18
64	spot RGB, 120 Watt, PCB, 215 MM - 72 LED	2
65	F RGBW, PCB 3535 - 24 LED	18
66	FRGB 120, 62 LED	17
67	IGS 18, PCB 3535, 86 LED	7

68	STO 15, 8 LED	22
69	STO 20, LED 16, 3030	252
70	Edgemax PCB, 9 Watt, 3030	9
71	PLL B10 scrap	3
72	STO 40, PCB 3030 LED	28
73	Driver PCB For Ganpati Decoration	500
74	Driver PCB ES22 36V	120
75	Matrix PCB 24 LED 3535 Import	23
76	Matrix PCB 56 LED 3535 Import	80
77	Alpha Wide light FR4, PCB	274
78	FLC 90, NSW 28, LED 3535 LED	17
79	IGS 2, 3030 LED (PCB)	78
80	Beta Light 3V,	5519
81	Under Water Light 18W, PCB 3535, 7 LED	478
82	FRGBw 90W, 3535 LED, PCB	22
83	STL- 80W, PCB	34
84	STL-135W, 3535 LED	85
85	PLCC - 12W, RFM 12, PCB, 12 LED	95
86	STO 90, 3535 - 72 LED	36
87	TR24, 24 LED	13
88	Matrix 90w, 72 Led, 3535 - PCB	31
89	Street Light - 105W, 3535 - 20 LED	20
90	STL- 165W, 76 LED- 3535 PCV	16
91	STL - 165W, 74 LED, PCV	5
92	SF - 12W, Assessories PVC - 60 LED felxible	1020
93	SF - 18W - Assessories PVC - 90 LED	600
94	RLP 12W, Assessories PVC - 60 LED	400
95	RLP 18W, Assessories PVC - 60 LED	420
96	WLM 40/45, 12 LED - 1 Feet, PCV	284
97	STL 150, 128 LED, 3535	23
98	Pin Lock for connector plastic L15	11000
99	Fuse Holder Screw Cap for Highbay	295
100	Gasket	127
101	Hacks Bolt (5MM * 78)	21
102	Connector (12 way strip connector)	1620
103	4 way Connector	130

104	2 Pin Connector	235
105	Pin Lock	1500
106	3 MM Nut	0.24
107	M5 Spring Visher	0.32
108	M3 Spring Visher	0.07
109	Screw (M3 * 15mm)	0.68
110	6mm Nut	0.4
111	5mm Nut	0.55
112	CSK M3 * 8mm	0.3
113	CSK M4 * 8mm	0.21
114	CSK M4* 5mm	0.52
115	CSK M3 * 12mm	0.33
116	Lambertion White LED	5328
117	2835 (0.2W) - White LED	54
118	RGB LED 5050	3000
119	2835 (0.5W) WARM WHITE	600
120	2835 0.2W WHITE LED	133000
121	2835 0.2W WHITE LED	40000
122	2835 WHITE LED	200000
123	3737 3W WARM WHITE	2000
124	5050 WHITE	1000
125	5050 6W LED WHITE	7500
126	2835 0.2W WHITE	3700
127	5050 BLUE LED	1000
128	3528 0.2W WHITE	1000
129	3528 0.2W NEUTRAL WHITE	6000
130	SMD 5730 WHITE	15000
131	2835 0.2 LED WHITE	4000
132	COB 10W - 20W WHITE	22
133	COB 30W - 40W WHITE	28
134	COB 100W - 150W WARM WHITE	24
135	COB 150W - 200W WHITE	90
136	5524 WHITE LED 0.2	4000
137	DIODE S24 SMD	8000
138	REGISTOR R07 OR2	8000
139	REGISTOR YAGCO RC 2512 K-07 OR	8000
140	3535 WHITE	2300
141	HIBAY J HOOK	44
142	COPPER MINI BOLARD LIGHT GI Reduser	55
143	BALARD LIGHT MINI COPER GI Reduser	32

144	BOLARD PIPE 0D 42mm X 105mm MS	5
145	BOLARD RING BIG Alum	41
146	BOLARD REDUSER BIG Alum	21
147	BOLARD LIGHT Reduser GI	20
148	BOLARD REDUSER BIG Alum	7
149	BOLARD SMALL REDUSER	21
150	BALARD RING BIG Ring	36
151	BALARD BIG REDUCER	48
152	ALUMINUM PIPE	2
153	THICK WASH CLAMP	10
154	HANGING CABLE wire	111
155	THIK WALL WASHER CLAMP	91
156	PG7 GLAND PLASTIC	100
157	PG9 GLAND PLASTIC	350
158	M10 GLAND SS	3000
159	PG 7 GLAND PLASTIC	1130
160	PG7	760
161	PG 9	100
162	PG 11	71
163	PG 7 GLAND PLASTIC BODY	1350
164	1 FT IRON CHAIN MS	48
165	1 Mtr IRON CHAIN	1
166	HOT MELT GLASS STICK glue stick	96
167	SS gland 22mm	37
168	PG 7 PLASTIC	70
169	WHITE Tape insulation PVC	30
170	PVC INSOLATION TAPE	58
171	TABLE TIE PACKING 130mm	1800
172	PACKING TIE	130
173	PG PLASTIC PG7	200
174	PG 7 GLANG PLASTIC	150
175	GROOMIT RUBBER for Highbay	6624
176	EARTHING LOG	3000
177	GROOMIT RUBBER 10mm for ESP tube	400
178	GROOMIT RUBBER BLACK for highbay	5900
179	HANGING CABLE SS	28
180	SOLDING WIRE	20
181	SOLDING MACHINE	3

182	6/1 INCH RLAP WHEEL Scap	3
183	GROOMIT RUBBER BLACK for highbay	150
184	HOT GLASS STICK	2
185	GROOMIT BIG 18mm	10
186	M12 GROOMIT	20
187	M8 GROOMIT	30
188	140 BUTTON	40000
189	ES22 GROOMIT	2000
190	L15 WIRECLIP	200
191	ONLY BLACK C LIP	200
192	SLP 18 WIRE CLIP	1600
193	LED foam Stick	1800
194	JUMPER WIRE	2
195	PG 7 GROOMIT SS	70
196	RIBIT 4mm	100
197	GROOMIT PG11	70
198	BOLARD DOME	38
199	BOLARD POWER SUPPLY - Plastic diffuser	140
200	IGS 36 Housing alum PCB heatsink	75
201	100W HIGHBAY RING	30
202	FLM 60 HEATSINK Plate alum	12
203	IGL 12 Alum Plate	10
204	IGS 36 FIXTURE PCB Mount Plate	4
205	GL 12 PCB Mount Plate	30
206	BOLARD DOME BL5 Top Cover	7
207	HIGHBAY DOME GLASS	245
208	PTX DOME COVER PVC	147
209	MX 60 Heatsink	46
210	BOLARD DOME BL5 Masroom	20
211	OWDS 12 FIXTURE Scrap	1
212	LGP 12W Plastic	46
213	FLOWER POT REFLECTOR (Glow ball base)	40
214	BAYSTAR Dome	5
215	FT - 12 Housing scrap	1
216	HIGHBAY DOME PLASTIC For COB clear	226
217	GL GLASS	50

218	BULB DOME PLASTIC for COB Milky	520
219	GASKIT FLOODLIGHT 10X25	250
220	THIK WALL WASHER GASKIT	100
221	FLC 18 FIXTURE	4
222	LUCIO R12 Plastic scrap	3
223	LUCIO R13 Plastic scrap	5
224	LUCIO R14 Plastic scrap	2
225	UFO 100	4
226	X9 Alum housing	1
227	S12 Alum Housing	7
228	UL 12 plastic housing	1
229	STO 100 GLASS	45
230	STO 15 GLASS	3
231	GL 3	2200
232	STO GLASS 100	14
233	STO GLASS 100 REFLECTOR	2
234	FLOODLIGHT GLASS	85
235	GL6 GASKIT	500
236	IGS 36 GASKIT	75
237	STO GASKIT	100
238	FLR- 18 fixture	4
239	FLR 9 fixture	2
240	STO 15 GLASS	100
241	FLOOD LIGHT GLASS 100W	135
242	30W GLASS	16
243	60W GLASS	2
244	FLP 10 GLASS	305
245	STO GASKIT	900
246	TUBELIGHT BOX 4X2	190
247	1 NO ROROGEL FUD BOX	30
248	2 NO FORGO TUD BOX	160
249	WALL Washer Box small	4

250	WALL WASHER 4FT BOX	150
251	LUMINEX BOX inner part	50
252	HIGHWAY DOME BOX	3
253	BL 5 DOME Plastic	100
254	BOLARD PCB Alum. Plate	150
255	GL3	16
256	FLOOD LIGHT Back dome import Ms	4
257	XLG L401 H-A Driver M/W	3
258	BALARD DOME Alum	35
259	GRINDING WHEEL Scrap	4
260	CUTTING WHEEL Scrap	4
261	SLP 12 FIXTURE	17
262	LUMINEX SPOT LED LIGHT	44
263	WIELDING ROD ORANG -308L	1
264	HIGHBAY DOME ALUMINIUM	23
265	LUCIO 30 FIXTURE	2
266	VIN LED DRIVER LFG246B 5Watt	34
267	VIN CLASS 2 POWER SUPPLY 4Watt	8
268	PL OR -3 Fixture	9
269	GL 3FIXTURE	2
270	THICK WALL WASHER GLASS	11
271	GL- 6 3W POWER SUPPLY 3W Import	20
272	BATA WALLWASHER GLASS 12 LED	109
273	RCCB 2P 25A-30mA AC Old	22
274	MCB 24014515UC 1P Old	25
275	MCB 4P C40 415V Old	6
276	MCB 2P C40 415V Old	1
277	CUTOUT 63A GRIP Old	4
278	CUTOUT 100A TANLAY old	1
279	CUTOUT BOX 63A old	1
280	FLOODLIGHT REFLECTOR Scrap	320
281	FLOOD LIGHT REFLECTOR MEDIUM Scarp	1005
282	FLOODLIGHT REFLECTOR SMALL Scrap	1900
283	FLOOD LIGHT CAP SIZE- 120 reflector scarp	20
284	FLOOD LIGHT CAP SIZE - 50 reflector scarp	17

285	HITSINIK 120 CAPACITY LED refelector scrap	171
286	FRGB REFLECTOR Scrap	320
287	SLP 18 FIXTURE	137
288	DYNALIGHT 30 FIXTURE	4
289	DYNALIGHT 20 Fixt	3
290	IGSR Fixt	2
291	PLO OC 2 FIXTURE	2
292	IGDR FIXTURE	2
293	MIRROR LIGHT FIXTURE	10
294	PLOR1 FIXTURE	1
295	UL 10 FIXTURE	1
296	FT 9 FIXTURE	6
297	THIK WALL WASHER PRINTED Glass	40
298	BLAIR	7
299	STO 60 GLASS	4
300	2 FT GLASS	50
301	36 LED GLASS	20
302	12 LED GLASS	10
303	BLANK GLASS Beta	14
304	4FT 28 LED	10
305	24 LED GLASS	16
306	28 LED GLASS	32
307	36 LED GLASS	36
308	12 LED GLASS	12
309	24 LED GLASS	26
310	BLANK LED GLASS	1
311	THICK WALL WASHER 4FT GLASS	1
312	21 LED GLASS	15
313	24 LED GLASS	45
314	36 LED GLASS	10
315	30 LED GLASS	22
316	LENS (LENSTECH) LENS2 - S15	500
317	ILENS2 - S15-M15-NH	1000
318	ILEN 480 S22-1045- NH	1500
319	ILENS480-S22-30 NH	1500
320	ILENS480-S22-60 NH	500
321	REFLECTOR Paper Scrap	500
322	FLR FIXTURE	2
323	IGL 12 FIXTURE	4
324	FT 9 FIXTURE	2

325	WLW3 FIXTURE	6
326	PLORAL3 FIXTURE	9
327	OWSS FIXTURE	1
328	GL3	4
329	IGS6	10
330	IGS35	4
331	BOLARD GLASS	4
332	IGS36	41
333	IGS12	6
334	GL20 SPOTLIGHT	20
335	STO 150 GLASS	12
336	STO 15 GLASS	5
337	I LENS2- S15 - B45 - NH	2000
338	I LENS 480-S22-60 NH	1000
339	I LENS 480-S22-30 NH	1500
340	I LENS 480-S22-12NH	1000
341	I LENS 28-S20-B110-H-03192	3430
342	I LENS S2-S15-B45-NH	450
343	I LENS 480-S22-12-NH	1498
344	I LENS S2-S15-M15-NH	498
345	Lens-28-S-20, 10*45	3609
346	S-20, 10*70	960
347	S-13, 60 Degree	553
348	S-20, 15 Degree	2230
349	S-20, 25 Degree	460
350	S-20, 60 Degree	128
351	S-13, 10*45	4836

352	S-13, 60 Degree	1800
353	S-13, 10 Degree	4585
354	S-13, 30 Degree	573
355	S-13, 45 Degree	4000
356	S-13, 15 Degree	1000
357	S-13, 20*60	2600
358	S-13, 25*60	2100
359	S-13, 30 Degree	1950
360	Lence Eclipse, STO 5050	100
361	S-20, 45*60	1000
362	S-20, Cap	1180
363	FL 45*60 - Lence Only	4280
364	FR - 45 Degree	920
365	FL, 45*60 Lence Only	7625
366	STO- LENCE-20 MM	490
367	S-20, 30 Degree	144
368	S-22, 30*45	150
369	LCO1, LENCE ONLY street light lens	15000
370	FL, 45*60 Lence Only	118
371	5050- Lence Only	298
372	S-23, 15*18 - Lence Only	250
373	OMPL - 120 Model	820
374	S-23, 30 Degree	25
375	S-23, 15 Degree	34
376	S-23, 15*40	19
377	S-23, 15*60	30
378	S-23, 60 Degree	25
379	S-23, 45 Degree	25
380	S-21, 6*180	16
381	S-23, 10 Degree	35
382	S-20, 30 Degree	200
383	S-21, 6*180	3
384	S-20, 10*65	10
385	S-23, 10 Degree	15
386	S-5540, 3*180	1
387	Mini Lence	150
388	S-20, 10*60	165
389	STO Lence	50
390	S-20 5050	330
391	S-20, Cap Only	330
392	S-20, 5050	50
393	Stone Lence street light	55870
394	Stone Lence street light	15000
395	12 Degree Lence Big	32
396	FR - 45 Degree	144

397	S-20, 30 Degree	1900
398	OMPL- 120	1628
399	IGS 9 - Lence Only	11
400	S-20- 4 LED, Lence Only	50
401	S-20, 30 Degree	595
402	S-20	500
403	S-13	2500
404	S-20	700
405	OMPL	35
406	FL-45*60 - Lence With Cap	68
407	S-13, DF 60 Degree	435
408	S-22, 10 Degree	425
409	S-13, 10 Degree	150
410	S-13, 10 Degree	360
411	S-20	500
412	Trio 3 Bulb - Led Lence Only	28
413	S-13, 10 Degree	300
414	LC001 - 000	1000
415	STO Lence, 20 MM	9200
416	STO Lence, 15 MM	1145
417	S-22, 40 Degree With Cap	3895
418	S-22, 10*45 With Cap	2325
419	S-20, 30 Degree	245
420	FL - 5050	1740
421	S-20, Lence Only	52
422	S-20, 40 Degree Lence with Cap	2232
423	S-13, 30 Degree With Cap	4500
424	BL-1, 30 LED PCB	230
425	F-30, PCB	3
426	F-30, PCB	5
427	FLP-30	47
428	F-200	86
429	F-250	1
430	F-120	39
431	F-120, RGB	59
432	LENEA - 4 FR	2000
433	STAR - DCB	3030
434	LFD	3080
435	ALPHALITE - 4 FR	100
436	STAR PCB, 1 LED	150
437	ALPHA LED PCS FR	1090
438	ALPHALITE - 3	972
439	FLP - 130	45
440	FLOOD LIGHT - 3050 scrap	40
441	EDGE MAX PCB, 6 LED	135

442	EDGE MAX PCB, 3 LED	40
443	VAR10-15, PCB	73
444	STO-45	11
445	R-12	588
446	TR-15, 45 LED	116
447	STO-90	236
448	CUBIX, 1X1 - PCB	48
449	CUBIX- 2248	44
450	CUBIX - 2234 FR Material	2
451	STO-45, PCB	121
452	STO-85	12
453	STO-80 NEW	20
454	STO-80 OLD	36
455	STO-100	3
456	SSTL-12	25
457	STO-30 NEW	0
458	SSTL-18	30
459	F-150, 70 LED	21
460	STL-110, 48 LED	10
461	STL-15, PCB NEW	10
462	MAPLE - 222, F	33
463	STO-60	6
464	SSTL-36	1
465	STL-20	12
466	Mini Optima - 3 PCB FR Material	18301
467	OPTIMA - 3/ PCB FR Material	10799
468	OPTIMA - 3 (SAMSUNG) FR Material	1459
469	OPTIMA-4, RGB PCB FR Material	10640
470	F-30W, 2835	22
471	STL-120 PCB	14
472	F-150, 5050 LED	59
473	STO-90, 3030 LED	100
474	STO-120, 54 LED	6
475	EDGE LITE PCB	400
476	OPTIMA - 4 PCS (SUMSUNG) scrap	3000
477	TL-10D, BIG PCB	900
478	CUBIX PCB	500
479	STO-120 PCS	6
480	ES-22, PCB	250
481	S-1, PCB	1330
482	MS-14, PCB	20
483	GOLD BAR, PCS	235
484	ER-9, PCB	100
485	12R - 18, PCB scrap	1820

486	I-40, PCB	701
487	BOTTOM, Pixel double entry	1200
488	99186 THICK WALL Washer FIXTURE 250Kg	131
489	90622 CROMTION PROFILE 130Kg	32
490	90654 THICK CLAMP PROFILE 115Kg	40
491	H SHAPED PROFILE old 45Kg	60
492	Fixture Beta WALEB Gray 32Ntotal weight 18Kg	18
493	Coated Beta Waleb - G - 54 N30Kg	30
494	Coated Beta Waleb - G - 54 N30Kg	30
495	Scrap Flap (Wall) G 180 Nos 18Kg	18
496	F1 Beta WW G-179Kg	9
497	F Beta ww G-18 N Profile9Kg	9
498	F Beta ww G-30 N16kg	16
499	F Beta ww G-30 N16Kg	16
500	F Beta ww G-30 N16Kg	16
501	F Beta ww G-32 N17Kg	17
502	Used Scrap Roshan Space - WLX Scrap18kg	12
503	Bottom Profile Gold Bar L-50010kg	100
504	Brown Coated Profile L-500 Flap8kg	100
505	Flap Gold Bar L-50010kg	80
506	Used Alpha - WW Scrap80kg	76
507	Alpha WW Scrap3Kg	3
508	Hamas - 150 Scrap3Kg	4
509	Old Beta - Small Wall Washer22kg	60
510	Alpha Wall Washer 26Kg	63
511	Round Pipe Dia 42mm120Kg	13
512	Saphire Patti125Kg	60
513	Pool Road 1 Feet BL 5 Pipe MS - 1mtrt610Kg	6
514	Pool Road 2 Feet BL Pipe MS - 1.5mtr480Kg	40
515	ES-22, Profile Scrap250Kg	24
516	Beta Wall Washer Flap3kg	8
517	Crompton Profile 34Kg	8
518	Gold Bar Profile365kg	160
519	Crompton Profile 34Kg	89
520	Aluminium Scrap- Patti50Kg	3
521	90925 - Neon Profile170Kg	0
522	90264 - Pixel Profile Bottom925Kg	2137
523	90265 - Pixel Profile Top300Kg	98
524	Sapphire Profile 125Kg	820
525	Wall Washer Raket Profile50kg	218

526	Highway Light Heatsink 150 Watt 260Kg	118
527	Highway Light Heatsink 100 Watt 8Kg	1800
528	Highway Heatsink Wet- 17.82Kg alum213Kg	4500
529	Highway LS - 100 Watt (Black body) scrap40Kg	78
530	PTX - 200 Watt Heatsink alu 780kg	1001
531	PTX - 200 Watt Cover Top Plate Alum540Kg	30
532	HighBay Housing 100 Watt alum, 5	40
533	TUBELIGHT PLASTIC PACKING PP Rollrolls	2801
534	THICK HALLWASHER HEATSINK crompoten profile65Kg	140
535	CARPET ROLL GREY mattroll	1
536	CARPET ROLL GREEN mattroll	0
537	MLC PROFILE ALUMINIUM 0.5kg	750
538	FLC HG- PROFILE alu scrap 7Kg	1922
539	old linear FIXTURE 15kg	1688
540	WALL WASHER FLL- 44 FIXTURE13kg	300
541	Wall Washer Raket Profile	50
542	Highway Light Heatsink 150 Watt	45
543	Highway Light Heatsink 100 Watt	3
544	BL-1 Import Fixture	6
545	PTX Stand MS	7
546	Highway Lence + Ring scrap	0
547	Black Blank EL-12 packing box scrap	50
548	BS-9-1 Feet DS 9 profile 1ft scrap	160
549	DR-9 - 2 Feet - Tublight Fixture	1
550	DR-9 - 1 Feet - Tublight Fixture	1
551	Flood Light Fixture scrap	5
552	Flood Light Clamp Scrap	5
553	Flower Leaf Stand Iron Rose	35
554	Flower Leaf Rose	97
555	Flower Stand rose rod	35
556	Flower Set Pipe Round	17
557	Flower Dome sink	1
558	ESP 18 Plastic Square T5 White Length 1126 Fixture	1904
559	Tublight Fixture ER alu scrap	16
560	Tubelight Fixture DR+Accrelic scrap	50
561	ESP 18 Plastic Square T5 Plastic diffuser	2800

562	ESP 18 Plastic Square T5 Plastic diffuser	8672
563	ESP 18 Plastic Square T5 Mounting Clamp	8000
564	Packing Material - Bubble Rapper	3
565	ESP 18 Plastic Square T5 Plastic Tublight Side Cap	16000
566	ESP 18 Plastic Square T5 White T-5 Tublight Fixture - Length 1126	8400
567	ESP 18 Plastic Square T5 White T-5 Tublight Fixture - Length 1126	676
568	Cubix fixture	70
569	L15 Ring PVC Scrap	3000
570	Highway Heatsink Wet- 17.82Kg alum	12
571	GL-6 Fixture	151
572	GL 6 C- Braket	80
573	Panel Light Fixture M-16 Scrap	32
574	Tublight Ceiling Fixture Scrap	8
575	L-5 Empty Box (P.M.) packing box Scrap	200
576	L-8 Empty Box (P.M.) scrap	300
577	Festive - 9 White Box (P.M.) scrap	200
578	GL-6 Empty Box (P.M.) scrap	473

579	PTX Empty Box (P.M.) scrap	300
580	L-22 Empty Box (P.M.) scrap	400
581	STO - 30 Watt Empty Box (P.M.) scrap	400
582	Bulb 9 Watt Empty Box (P.M.) scrap	6000
583	Festive - 9 / 100 pc Paking Box (P.M.) scrap	30
584	Tekrak5 - Ring PVC scrap	600
585	Black Lamp - Fixture (Hanging) Decorative aga khan	80
586	Polycab Wire - Class5- 30X0.75 Sq. mm.	800
587	Polycab Wire - 5C X 0.5 Sq. mm.	400
588	Polycab Wire - 5C X 2.5 Sq. mm.	100
589	Polycab Wire - 3C X 4 Sq. mm.	700
590	Wire - 2C X 1.5 Sq. mm	200
591	Prime Cables - 14/40 Twin Flat Wire	644
592	Prime Cables - 40/39 Twin Flat Wire	460
593	Prime Cables - 14/40 Twin SPK Wire	92
594	Wire - 1 M.M. wire 14/36 Single core wire	400
595	2 Pair - 0.51 mm- Telephone Wire	100
596	2 Pair - 1 mm- Telephone Wire	100
597	Speaker Cable - OFC - Polyeb - 2C X 0.32 Sq. mm. Make 2022	90
598	2Core Teplon Wire - Thin	1400
599	Telephone Wire - Black	400
600	Panel Wire FR - Single core - 1.5 Sq. mm. (Polycab)	400
601	Polycab Wire - 4 sq. mm - 2022	60
602	Polycab - 2C X 0.32 Sq. mm - 2022	100
603	Panel Wire FR - Single core - 1 Sq. mm.- 2023 (Polycab)	200
604	Panel Wire FR - Single core - 1.5 Sq. mm.- 2023 (Polycab)	410

605	Polycab Wire 2.5 sq mm	230
606	Polycab Wire - 2.5 Mtr - 2019	900
607	KP Plast Wire - 3 Core - 2018-19 - 0.5 Sq.mm	304
608	Polycab 3C X 0.5 Sq.mm - 2019	500
609	New Caf - 16/200 - 0.50 Sq. mm- 3 core - 2016	400
610	Polycab - 0.5 Sq.mm - 4 core	600
611	Maheshwari Wire - 14/6060-4 Core Ribbon	1820
612	Polycab - 4 Core - 6 Sq. mm.Wire	300
613	KEL Wire - 2.5 Sq.mm - 2019 Flexible	500
614	Gold medal - 100 Mtr - Copper	200
615	Polycab - 4C X 2.5MM	400
616	Wire 3 Core - 1.5 Sq. mm.	40
617	2 Core Flat Wire - 14/40	50
618	2 Core - 1.5 Sq. mm	30
619	3 Core - 0.5 Sq. mm	30
620	14/40- 2 core Flate Wire	100
621	3 Core - 0.5 Sq. mm	50
622	2 Core - 1.5 Sq. mm	15
623	3 Core - 5 Sq. mm	10
624	3 Core - 0.5 Sq.mm	25
625	3 Core - 0.75 Sq. mm	25
626	3 Core - 0.5 Sq. mm	15
627	FLT - 18 Fixture	5
628	FLR - Reflectore	432
629	Polycab - 1sq mm MM Wire	270
630	Polycab - 1.5 Sq. mm -2023	400
631	Polycab - 2.5 Sq. mm - 2023	600
632	FLR - 60 Reflectore scrap	200
633	Junction Box size 440 x 440mm	18
634	Rapping Roll- Small size 3inch	235
635	3 inch tape brown packing tape	32
636	3 inch Cello Tape Packing Tape	36
637	RCB - 4P- 30AMP	14
638	Screw Mix	195
639	ESDEE Color Lacker paint Duco	5
640	Rapping Roll- Big 24inch	3
641	Plastic Mounting Clamp 140	Half Trey
642	Side Cap 140 Plastic	Full Trey
643	Tubelite Side Clamp old scrap plastic	Full Trey
644	Fitter (2B) scrap	Full Trey
645	Matelax Side Cap MS Scrap	Full Trey 2

646	PTX Clamp (L) 120 MS Scrap	Full Trey 2
647	Two Pin Connector with wire scrap	Half Trey
648	140 Plastic Clamp	Full Trey
649	140 Metal Clamp	Full Trey
650	Wall Washor Side Cap White (L)	170
651	Wall Washer Side Cap Silver ®	100
652	Wall Washer Side Cap Silver (L)	100
653	Wall Washer Side Cap Silver ®	80
654	Wall Washer Side Cap Silver (L)	100
655	Wall Washer Side Cap Silver ®	150
656	Wall Washer Side Cap Silver ®	170
657	Wall Washer C Clamp	350
658	STL Leaf wrong entery	40
659	Tubelight pin protector	1400
660	Mix Tublight Tre old plastic scrap	700
661	Oil Filter (A+B Gun) plastic cap	1 Trey
662	C Clamp PTX MS scrap	3 Trey
663	Think Wall Washer Side Cap	450
664	Wall Washer Side Clamp Left and Right	800
665	Wall Washer Mounting Clamp (Alpha)	400
666	Wall Washer Mounting Clamp (Beta)	500
667	Flood Light 50 Watt Fixture	24
668	PTX - Back Power Supply Box scrap	380
669	Highway LS - 100 Watt (Black body) scrap	21
670	R-100 Heatsink danged scrap	139
671	PTX - 200 Watt Heatsink alu	160
672	PTX - 200 Watt Cover Top Plate Alum	170
673	Vin Nexa - 50 rgb New Packing Case Thick Wall Washer 24 LED 3535	126
674	Matrix 60 Watt PCB - 54 LED	60
675	Matrix 80 Watt PCB - 72 LED	80
676	hls Highway 150 Watt PCB - 5050	450
677	HLS 100 Watt PCB - 20 LED	60
678	FLP/120 - RGB - 36 LED - PCB scrap	205
679	FLC-90-RGB- 30 LED scrap	35
680	F-150-200 PCB - RGB scrap	12
681	STO-45/60 Khatod Lence scrap	18
682	FLC - 90W - RGB PCB scrap	36
683	Flood Light PCB - 200 Watt White Scrap	10

684	STL - 120-3030- 104 LED scrap	86
685	STO - 120- 112 LED	174
686	STO - 90 - 72 LED	57
687	FLP-120-36 LED	10
688	L-15 PCB-21LED	225
689	L-22 PCB - 26 LED	435
690	L-8 PCB - 12 LED	100
691	Over Votage Cut Off CKT PCB FR Scrap	650
692	STO-210-PCB	1
693	F-250 PCB - 110 LED	7
694	MLC-PCB-50 LED	23
695	OL - 12 - PCB Holder Cover	344
696	STO - 60 3030 LED - PCB	270
697	FLC - 9D - 70 LED - PCB	10
698	Matrix - 60 Watt - 54 LED	4
699	PTX - 45 - PCB - 241 LED	80
700	IGS - 18 - PCB - 18 LED	150
701	IGS - 36 - PCB - 36 LED	98
702	Alpha - 21 led- rgb	59
703	Alpha - 24 LED - RGB	31
704	Alpha - 28 LED - RGBW	100
705	Alpha - 20 LED - RGBW	101
706	Beta 20 LED PCB	22
707	ML-36 Fixture Scrap	81
708	F-200 Flood Light Fixture	1
709	F-20 Flood Light fixture Scrap	18
710	Scrap	3 Box
711	Heatsink - 50 Watt scrap	18
712	Flood Light - 200 Watt - F-200 Fixture	33
713	F-100 Fixture scrap	6
714	F-50 Fixture scrap	28
715	F-120 Fixture scrap	7
716	Spot Light 36 Watt fixture scrap	26
717	IGS 36 Watt Fixture scrap	9
718	143 Lites - 350 E- Fixture scrap	2
719	Spot Light - 46 Watt Fixture import	3
720	Flood Light - 120 Watt - Fixture scrap	22
721	Spot Light - 9 Watt - Fixture	17
722	FLP - 120 Watt - Fixture scrap	30

723	Wall Light 36W round flood light import white	70
724	F-120- Housing - Fixture scrap	6
725	Spot Light - 46 Watt Fixture scrap	1
726	FLM - 60 - Fixture scrap	1
727	FL - 50 scrap	3
728	Ground Light Fixture - 30 Watt scrap	3
729	STL - Housing - LE Power - Bottom scrap	21
730	SLE - 10 - White - Fixture scrap	20
731	Flood Light - 35 Watt - Fixture scrap	6
732	LED Street Light Top scrap	15
733	LED Module - 60w- White scrap	11
734	BL-1 Fixture	82
735	Drop Location Difuser - Not Found	72
736	Tubelight ER-18 Heatsink Profile	2000
737	STL-60(80) fixture scrap	42
738	FLM-25 fixture scrap	5
739	ID - 120 Fixture fixture scrap	46
740	RLOR-4 fixture scrap	20
741	OWDS-12W fixture scraop	65
742	HighBay Housing 100 Watt alum,	8
743	SL-8 fixture scrap	22
744	PTO - 30	1
745	FLM - 110	3
746	FGL - 30	15
747	PTO-30	6
748	ER-9 Profile scrap	350
749	ER-18 Screw Fitting Cap scrap	2600
750	Tublight Side Cap - Screw Fitting	3700
751	ER-18 Diffurer PVC scrap	1060
752	Diffusee Sheet ER 18 Tube PVC Scrap	760
753	ES-20W-White Profile scrap	7
754	ES-9W-White Profile scrap	25
755	ER-18 alum-Heatsink Profile scrap	1500
756	ER-18 End Cap PVC	1100

757	Tube Patri Blue Cap scrap PVC	95
758	ESP18 Tube Profile T5	500
759	Cubix Fixture Dropdown	200
760	L15 Spring scrap	13,275
761	L15 Clamp scrap	2020
762	GL3 Glass	23
763	L15 Small Spring scrap	9945
764	GL 6 TOP Cover	53
765	GL 6 BACK SIDE COVER	460
766	GL6 Rubber gasket	1000
767	GL6 PCB	608
768	GL6 Screw	2000
769	GL6-6 Watt-PCB CV	395
770	GL6 Lence	800
771	GL6 Glande	1200
772	GL6 Glass	291
773	GL6 Fixture	31
774	Fixture Used mix scrap	18
775	L500 Side Cap	1180
776	GL6 Fixture old scrap	45
777	GL6 Upside Cover plastic	84
778	GL6 Glass	362
779	Cubix 36 Clamp scrap	1632
780	Plastic Cap (Tublight) old scrap	1088 Black
781		2176 White
782	Highway Dome ALU scrap	17
783	18W Power Supply Tube light	15
784	18W Power Supply tube light	18
785	Crompton P/S 36W old	1
786	Fulham P/S - 36-24-36 old	2
787	E9 Bulb P/S old	123
788	Fulham P/S - 18-24V, 100MA	1
789	Euycmps P/S - 200-240V-700MA old	1
790	VIN Power Supply - SRDC - 320 old	5
791	Philips Power Supply - 20W/500MA/40V	1
792	L15 Clamp MS	9342
793	Aluminium Plate PS Fetting	424
794	Cubix Clamp scarp	152
795	L15 Clamp old scarp	532

796	1Watt Spot Light Fixture Black top cove old mix scrap	1264
797	1Watt Spot Light Fixture Black top cove old mix scrap	470
798	Aluminium Plate Small scrap MS	125
799	GL9 Clamp old scrap	447
800	L15 Clamp old scarp	3173
801	Clamp old scrap	93
802	Small Clamp scrap	75
803	VIN P/S 18W - BDA01803-4 old	20
804	VIN P/S - 17W/21-42V/0.4A old	4
805	VIN P/S 1.3W/10V/0.35A old	36
806	Pyrotech - P/S - 30W/28-40V/700MA	16
807	SLP - 3 P/S - 3W-280MA	900
808	FTC-12 P/S 12V open scrap	37
809	Power Supply i40	8
810	Power Supply 18W tube light old scrap	919
811	SPD - 10-350K	442
812	Aluminium Dome scrap	70
813	Max-50c/Max 70c-14.5w old	27
814	L15 Input 100-280V/26V/450MA	12
815	P/S - 55-200H/38V/200W old	8
816	SS -200 EI-58-200W old	15
817	Dali EVP30D-1HMC-30W/50V	2
818	Sosen -55-240h-54P-240W-56V/ 3.1-5 A	4
819	DL - 450MA - 13W - 50V old	35
820	Alssom P/S 100-240V/600MA/20W old	37
821	SLP-12 P/S - 12W/00-42V/75-235MA	44
822	GTP-022A-LB-MR-15 5.10W/12V/800MA old scrap	70
823	VIN - SPD - 10-350k	590
824	SRP5K -SIGN SAVER (Driver) plastic cover	590
825	IGS 36 fixture	14
826	IGS 1 Fixture	19
827	Tublight Paking Box - 4 Feet inner box	1175
828	Power Supply Cover scrap	420
829	IGS 6 Fixture	5
830	UL-12 Fixture	2
831	Moso P/S - EHC - 105B - 150- 120W/120-240V/0.70A	39
832	MW P/S - HLG- 120H-30A	6

833	Inventronics P/S - 100W/71-143V/0.7A	4
834	VIN P/S - 200H/28.5/175-325V/0.7A	11
835	VIN P/S - HG-WP-22100-100W/30-36V/2900MA	4
836	VIN P/S - GTP - 030A- 30W/30-40V/1.4A old	7
837	VIN P/S - HG-WP-2270-80W/20-40V/2300MA old	6
838	VIN P/S - HG-WP-2270-90W/40-50V/2000MA old	1
839	VIN P/S - EST - F120 - 120W/20-60V/2000MA old	4
840	Fulam P/S - 80W/36-57V/1400MA	4
841	Fulam P/S - 150W/225V/700MA	1
842	Inventronics P/S - EVG- 0965350DV - 96W/14-39V/3500MA	4
843	VIN P/S - HG-WP-22150 - 150W/30-45V/3300MA	8
844	VIN P/S - EST-F200 - 200W/35-45V/4000MA	3
845	VIN P/S - EST-F100 - 100W/32-42V/2500MA	2
846	VIN P/S - KV24260-A-DIM-360W/24V/15A old	2
847	Water Proof Led Driver - 150-150w/52-62v/2500ma	3
848	VIN P/S - 200H.285 - 200W/175-325V/700MA	2
849	VIN P/S - EST - F160 - 160W-30-45V/700MA	1
850	VIN P/S - EST- F160 - 160W/30-45V/3300MA	1
851	Moso P/S - LDP - 200R-054-2000W/20-54V/6.3A	4
852	MW - HLG - 100H-36A - 100W/36V/2.65A	1
853	MW - HLG - 320H-36A - 320W/36V/6.9A	1
854	MW - HLG - 150H-HA - 150W/27-56V/2.8A	1
855	LED Driver - MYW - 100W/22-39V/3A	1
856	VIN P/S- SS- 200H- 38B- 200W/24-38V/3.7-6.1A	1
857	Moso Control Gare - P/S - 150W/33-48V/2.8A	1

858	Water Proof Led - 200W-CV-200WI-12 - 200W/12V/16.7A	1
859	Water Proof Led Driver - 120W/50-60V/200MA	1
860	EST F- 30- 30W/30-35V/700MA	1
861	VIN- 150H-42B-150W/21-40V/2.5-4.5A	1
862	VIN P/S - GTP - 030B- 60W/32-40V/1.4A old	1
863	VIN LED Lighting - SPD10K - 350	235
864	VIN - I-40 Tublight Power Supply	450
865	I-36 - Tublight P/S	15
866	T/L Power Supply - EST - 053R - 85-95V old	75
867	Led Driver - 12- 30-36v/1500MA old	1
868	VIN Led Driver - L15-Q-15W/65V/230MA	1
869	VIN P/S - PL15-450- 15W/0.23A	1
870	FLR-15 fixture old scrap	3
871	IGS-36 dmage scrap	3
872	S5 Spot Light scrap	16
873	HIBAY DOME BIG scrap	24
874	HIBAY DOME SMALL scrap	50
875	IGS - 36 FIXTURE	25
876	LED PANEL DRIVER CC- 12 12W/22 - 28 VDC/ 430 Ma old	40
877	CONSTANT CURRENT DRIVER LD018H - CV03554 - 15 9- 18W/10-54V/350 Ma old	9
878	PHILIPS CERTA DRIVE - 12W R- 85000434 350mA - 28/40V	17
879	LED P/S VIN - 15W450 ME 15W - DC - 450mA	20
880	LED DRIVER / P/S ROCK FOREST 80 - 95W - 400mA old	7
881	WATERPROOF LED DRIVER LD - 12300 - 1A 2-12V 300mA	7
882	BULB GI45CVI.OA scrap	130
883	FULHM - LED DRIVER T12401000 -40P10B (40W) 30 - 40VDC - 1000mA	237
884	PI - 13D - 225AC 50Hz 0.21A 28-35VDC/450mA (Pmax - 16W) old	3
885	LED DRIVER LDRV 30W - H1 (25W) old	11

886	FULHAM - T12400700 - 25E10 25W - 18 - 36VDC 0.70A	173
887	PHILIPS DRIVER - C008C030V027FNMAI 8W - 300mA	90
888	PHILIPS (20W) 500mA 27-40V	98
889	VIN LED DRIVER VML - 18 18W - 0.45 - 0.65A old	115
890	ARCHANA TRANSFORMER 12V -1AMP old	1
891	IGS - 9 (FIXTURE) REJECTED	1
892	IGS - 18 (FIXTURE) REJECTED	4
893	IGS - 15 (FIXTURE) REJECTED	1
894	IGS - 7 (FIXTURE) REJECTED	1
895	IGS - 9 (FIXTURE)	7
896	IGS - 36W (FIXTURE) RETURNED rejected	1
897	POWER SUPPLY FLP- 12- old	38
898	LPH - 18 -12 (12V-1.5A)	2
899	XS - GWP40 - (24-42V) (0.9A) old	13
900	FULHAM - T12400300 - 07F 0.05A (9W) (300mA)	9
901	FULHAM - T12400610 - 22E10 18 - 36VDC - 0.61A (22W)	5
902	SL - 25 B1- 05 - 1182-23 4-1.3 18V DC@1.3Amp scrap	2
903	PHILIPS X150CO70V210FN180 XITANIUM - 150 W - 0.7A	9
904	EST - F200W 35-40W 4000mA	4
905	MOSO/EVC - 2005245ST-0074	3
906	PHILIPS - XITANIUM 36W 0.3 - 1A 48V 240V P2	6
907	PHILIPS (CO36C100V036FDE2A1) 36W 26V - 36V 0.8A - 1A	25
908	PHILIPS 18W LED 700mA 18-27V	12
909	PHILIPS 20W 350mA 40-60V	9
910	PHILIPS XITANIUM 36W - 1A240VML1	2
911	PHILIPS 27 - 40V 6W C006C015VO40FNM1A1 - 8W	37
912	IGS - 18 (FIXTURE)	1
913	IGS - 36 FIXTURE	1
914	IGS - 36 FIXTURE REJECTED	1
915	IGS - MEDIUM FIXTURE	9
916	GL - 3W (FIXTURE ONLY)	20

917	EPIC TUBELIGHT DRIVER 20W/235mA old	270
918	BULB 9W POWER SUPPLY	233
919	PYROTECH - PI 13 - D - 106AC P/S 5W old	286
920	TEMPERATURE MACHINE 150W 2.45-4.9A AOC 230V 1220 PHILIPS XITANIUM	7
921	PHILIPS XITANIUM 75W - 1.05A	13
922	PHILIPS XITANIUM 150W - 1.05A	3
923	VMLCC4012- 9-12 LEDS - old	18
924	T/L DRIVER tube light	905
925	PHILIPS 150W 1.05A	96
926	APOLLO LIGHT FIXTURE	20
927	IGDR - 9W BLACK FIXTURE	11
928	LED DRIVER 0.7mA (85W) old	360
929	BULB - 6W- POWER SUPPLY old	45
930	POWER SUPPLY BULB - 6W,9W REJECTED	1
931	PHILIPS -LED DRIVER 0.7A 210-315VDE XITANIUM 220W	4
932	ANCHOR FASTENER	53
933	SC - MINIEYE -SILVER FIXTURE (OLD MATERIAL) CLAMP old	1580
934	TWO PIN CONNECTOR GLAND CAP Scrap	1750
935	MALE CONNECTOR	312
936	MALE CONNECTOR (BLACK)	100
937	GL-3 HEATSINK (BLACK) scrap	36
938	GL-3 RING scrap	50
939	GL -3 HEATSINK scrap	122
940	GL - 3 RING (BLACK) scrap	24
941	SPA - 6 FIXTURE scrap	81
942	CLAMP PATTI scrap	50
943	GL - 17scrap	80
944	RINGscrap	25
945	REGISTER FILES old dacumets	1
946	PAPER BOX - L8 old dacuments	800
947	PAPER BOX - L15 packing scap	400
948	LABEL STICK	144
949	L- BRACKET (FLL-120)	50
950	DOUBLE side TAPE foam	15
951	L- CLAMP scrap	60
952	TR-12 (FIXING SET) scrap alu	25
953	RING alu scrap	25

954	3M TAPE BLUE	166
955	1 INCH WRAP TAPE	25
956	HAYBAY HIGSING - not found	24
957	TRANSPRANT TAPE	166
958	MASKIN TAPE (BIG)	52
959	MASKIN TAPE (SMALL)	660
960	3M TAPE RED	10
961	3mm BLACK SLEEVE (RSFR-H) 3.0/1.5	440
962	BLACK SLEEVE (2.0/1.0)	40
963	BLACK SLEEVE (5.0/2.5)	2190
964	BLACK SLEEVE (25/12.5)	405
965	BLACK SLEEVE (8/4)	50
966	BLACK SLEEVE (18/9)	4340
967	YSRH127 - 151M INDICATOR	16
968	DIYHOOD (CEIH100MIXANG)	17000
969	BLACK CLAMP PIN	1
970	IC- 201901TWHA (DIY OLD)	1500
971	SOT - 89 5L- LED - 1000EA	5000
972	SMD REGISTOR - 200K	2000
973	PTX - CAPACITOR 25W	4000
974	2W (REGISTOR) VALUE 10E	11000
975	SMD REGISTOR 47R	5000
976	MASKIN TAPE	1500
977	SMD- REGISTOR 620E	25000
978	SMD- REGISTOR 7E TO 5E	7900
979	SMD- REGISTOR 8E TO 2E	8000
980	SMD- REGISTOR 200R	6000
981	SMD- REGISTOR 1UF	2000
982	MOSPAD - 2008 W13009-0 (BLACK CAPACITOR)	30
983	RANK - 5W 10 E (WHITE REGISTOR)	30
984	1W REGISTOR 33K	500
985	MOSEPAD BLUE	250
986	REGISTOR 100E	2000
987	SD6910ETR (IC)	1000
988	REGISTOR 620E	5000
989	1R REGISTOR	3000
990	13K SMD REGISTOR	3000
991	SMD REGISTOR 43E	5000
992	150K REGISTOR	1000
993	1.4W SMD REGISTOR	1000
994	SMD REGISTOR 51R	4000

995	SMD REGISTOR 120K	5000
996	SMD REGISTOR 2.2K	5000
997	SMD REGISTOR 56E	5000
998	SMD REGISTOR 180K	5000
999	43E SMD REGISTOR	20000
1000	100K SMD REGISTOR	5000
1001	1R SMD REGISTOR	13000
1002	270E SMD REGISTOR	5000
1003	DIYHOOD (BLACK)	14250
1004	2.2R SMD REGISTOR	5000
1005	220K SMD REGISTOR	5000
1006	100UF SMD REGISTOR	30000
1007	4.7R SMD REGISTOR	5000
1008	7.5K SMD REGISTOR	3000
1009	82E SMD REGISTOR	5100
1010	68R SMD REGISTOR	3000
1011	45E SMD REGISTOR	5000
1012	WR12 SMD REGISTOR	5000
1013	330R SMD REGISTOR	10000
1014	47R SMD REGISTOR	8000
1015	1.2R SMD REGISTOR	5000
1016	150R SMD REGISTOR	500
1017	510R SMD REGISTOR	5000
1018	47K SMD REGISTOR	5000
1019	81E SMD REGISTOR	5000
1020	620E SMD REGISTOR	5000
1021	180E SMD REGISTOR	2000
1022	330K SMD REGISTOR	5000
1023	1K SMD REGISTOR	5000
1024	15K SMD REGISTOR	5000
1025	IC - 16 PIN ULN2003APG	1000
1026	ELECTROLIC CAPACITOR (B)	1000
1027	VARISTOR (070471K) (BLUE)	12000
1028	RANK - 25W 47E (GREY) old scrap	500
1029	ROYAL OHM RESISTOR 1W 160R	48000
1030	ELECTROLYTIC CAPACITOR 100UF/100V	5000
1031	1NCAP RADIAL (5X11) 10.00UF	2000
1032	8X10 INDUCTANCE 4mh	500
1033	SCK - 035 (GREEN)	2600
1034	FILM CAPACITOR 104J 630V	1000
1035	MST T6 3A 250V 63A 250V	10000
1036	HEATSINK (592) TR-12 alum	580

1037	RLP BACK COVER (ROUND) plastic scrap	43
1038	L-15 SPOTLIGHT REFLECTOR scrap	34
1039	GL- 3 RING scrap	25
1040	69QYL6POCA (PIN OF 7)	508
1041	L-5 METAL RING scrap	249
1042	TRANSPRANT TAPE 24X65Mtr.	720
1043	CHARM LUBRICANTS SIL LUB 65(A) /SILICONE HEAT (1KG) SINK COMPOUND pest outdated scrap	48
1044	ANABOND 654 (1KG) (W) SILICONE GREASE	5
1045	ANABOND 655 (1KG) (G) SILICONE GREASE	2
1046	RING scrap	25
1047	HEATSINK (OD - 90mm) alu scrap	44
1048	TR- 12 (REFLECTOR) BIG scrap	156
1049	TR- 12 (REFLECTOR) SMALL scrap	25
1050	C- CLAMP SMALL scrap	50
1051	C- CLAMP BIG scrap	70
1052	BLACK SLEEVE (18/9)	4440
1053	BLACK SLEEVE (8/4)	130
1054	BLACK SLEEVE (3.0/15)	300
1055	BLACK SLEEVE (5.0/2.5)	2150
1056	BLACK SLEEVE (25/12.5)	40
1057	BLACK SLEEVE	1
1058	WHITE SLEEVE 5mm	4
1059	MASKIN TAPE	288
1060	UV LIGHT GLASS 32W scrap	31
1061	BLUE TAPE SMALL	24
1062	BLUE TAPE BIG	32
1063	HYDROFLOURIC ACID	152
1064	VALUE 10E	2000
1065	VALUE 22E	2000
1066	DIODE (TUB)	1000
1067	EPC - 13 TUBELIGHT TRANSFORMER scrap	980
1068	INCAP 10.00UF BLACK	3000

1069	FLIM CAPACITOR 0.1UF RED	2000
1070	BLUE VARISTOR 7.0mm BLUE	3000
1071	METAL OXIDE FLIM RESISTOR BIG	200
1072	METAL OXIDE FLIM RESISTOR SMALL	100
1073	CLAMP scrap	600
1074	SILON MICROELECTRONICS IC- 7PINS	2100
1075	CAPACITOR (3.3UF) 250V	1600
1076	HICHICOA 1000UF 250W	420
1077	CLIP	1
1078	VALUE - 22E RESISTOR	10000
1079	470E	3000
1080	330E	5000
1081	470R	1000
1082	TUBELIGHT PLASTIC PACKING PP Roll	13
1083	STO - 15 FIXTURE scrap	42
1084	STO - 150 FIXTURE scrap	250
1085	LED Plastic casing led modules scrap	3
1086	BULB HOUSING 7W (OLD MATERIAL) scrap	60
1087	MS- 44/66 TUBELIGHT SIDE CAP scrap	1
1088	ALUMINIUM BRACKET scrap	11
1089	I BOLT scrap	35
1090	HIKSING mix scrap	3
1091	GREEN ROLLS vinyl scrap old	3

1092	L-15 FIXTURE ROUND OLD MATERIAL scrap	101
1093	REDDISH BROWN MATT powder	2
1094	FIXTURE ROUND ONLY SHELL L15 scrap	408
1095	ML-6 FIXTURE	30
1096	L-5 FIXTURE	423
1097	ML - 6 METAL RING	220
1098	ML- 6 HEATSINK	469
1099	L8 RING	1210
1100	SPD CASTING BOX scrap	300
1101	L5 RING	1165
1102	POWER SUPPLY COVER scrap	1
1103	THICK HALLWASHER HEATSINK crompoten profile	34
1104	CARPET ROLL GREY matt	1
1105	CARPET ROLL GREEN matt	1
1106	VISOR	200
1107	I40 diffuser	1000
1108	CLAMP/SLP/RLP spring scrap	400
1109	SYRING scrap	15
1110	REFLECTOR scrp	20
1111	TAFOLON TAPEworng entery	25
1112	SLP - 18 PAPER BOX	220
1113	SLP - 24 PAPER BOX	1900
1114	LED BULB PAPER BOX	800
1115	HIGHBAY LIGHT PAPER BOX	30
1116	STREET LIGHT PTEX -250 BOX	35
1117	PANEL BOX	35

1118	HIGHWAY LIGHT BOX	20
1119	Nexa WASHER InER BOX	20
1120	THERMACOL UV LIGHT	4
1121	STO - 120W FIXTURE scrap	40
1122	STO - 15W FIXTURE scrap	20
1123	STO- 60W FIXTURE scrap	50
1124	STO- 30W FIXTURE sacrp	20
1125	STO- 150W FIXTURE scrap	40
1126	R101 SMALL	60
1127	R101 BIG	50
1128	HEX BOLD 12mX157	50
1129	NUT	6535
1130	SCREW	1300
1131	STUD - HEXAGON	400
1132	HEXHEAD SELF DRINING SCREW	250
1133	HEXBOLT M6 X 104	150
1134	HEXBOLT M6 X 44	1000
1135	HEXBOLT M10 X 23	100
1136	CUBO C- 12 54mm	15000
1137	M10 NUT BOLT L&K	1300
1138	MLC PROFILE ALUMINIUM	19
1139	FLC HG- PROFILE alu scrap	16
1140	old linear FIXTURE	170
1141	WALL WASHER FLL- 44 FIXTURE	5